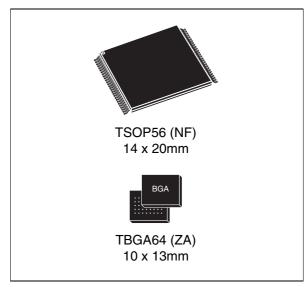


M29DW128F

128 Mbit (16Mb x8 or 8Mb x16, Multiple Bank, Page, Boot Block)
3V supply Flash memory

Feature summary

- Supply voltage
 - V_{CC} = 2.7V to 3.6V for Program, Erase and Read
 - V_{PP} =12V for Fast Program (optional)
- Asynchronous Random/Page Read
 - Page width: 8 Words
 - Page access: 25, 30ns
 - Random access: 60, 70ns
- Programming time
 - 10µs per Byte/Word typical
 - 4 Words / 8 Bytes Program
 - 32-Word Write Buffer
- Erase Verify
- Memory blocks
 - Quadruple Bank Memory Array: 16Mbit+48Mbit+48Mbit+16Mbit
 - Parameter Blocks (at Top and Bottom)
- Dual Operation
 - While Program or Erase in one bank, Read in any of the other banks
- Program/Erase Suspend and Resume modes
 - Read from any Block during Program Suspend
 - Read and Program another Block during Erase Suspend
- Unlock Bypass Program
 - Faster Production/Batch Programming
- Common Flash Interface
 - 64 bit Security Code
- 100,000 Program/Erase cycles per block



- Low power consumption
 - Standby and Automatic Standby
- Hardware Block Protection
 - V_{PP}/WP Pin for fast program and write protect of the four outermost parameter blocks
- Security features
 - Standard Protection
 - Password Protection
- Extended Memory Block
 - Extra block used as security block or to store additional information
- Electronic Signature
 - Manufacturer Code: 0020h
 - Device Code: 227Eh + 2220h + 2200h
- ECOPACK[®] packages available

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1 Summary description

The M29DW128F is a 128 Mbit (16Mb x8 or 8Mb x16) non-volatile memory that can be read, erased and reprogrammed. These operations can be performed using a single low voltage (2.7 to 3.6V) supply. At Power-up the memory defaults to its Read mode.

The M29DW128F features an asymmetrical block architecture, with 16 parameter and 254 main blocks, divided into four Banks, A, B, C and D, providing multiple Bank operations. While programming or erasing in one bank, read operations are possible in any other bank. The bank architecture is summarized in *Table 2*. Eight of the Parameter Blocks are at the top of the memory address space, and eight are at the bottom.

Program and Erase commands are written to the Command Interface of the memory. An onchip Program/Erase Controller simplifies the process of programming or erasing the memory by taking care of all of the special operations that are required to update the memory contents. The end of a program or erase operation can be detected and any error conditions identified. The command set required to control the memory is consistent with JEDEC standards. The Chip Enable, Output Enable and Write Enable signals control the bus operations of the memory. They allow simple connection to most microprocessors, often without additional logic.

The device supports Asynchronous Random Read and Page Read from all blocks of the memory array.

The M29DW128F has one extra 256 byte block (Extended Block) that can be accessed using a dedicated command. The Extended Block can be protected and so is useful for storing security information. However the protection is irreversible, once protected the protection cannot be undone.

Each block can be erased independently, so it is possible to preserve valid data while old data is erased.

The device features four different levels of hardware and software block protection to avoid unwanted program or erase (modify). The software block protection features are available in 16 bit memory organization only:

Hardware Protection:

- The V_{PP}/WP provides a hardware protection of the four outermost parameter blocks (two at the top and two at the bottom of the address space).
- The RP pin temporarily unprotects all the blocks previously protected using a High Voltage Block Protection technique (see Appendix D: High Voltage Block Protection).

Software Protection

- Standard Protection
- Password Protection

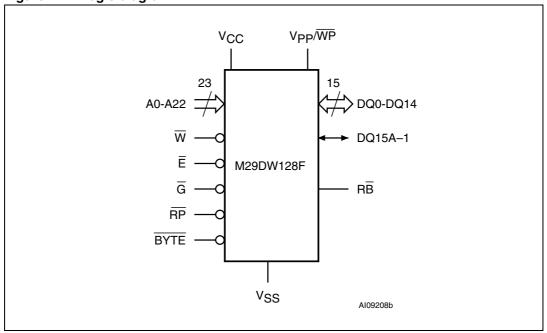
The memory is offered in TSOP56 (14 x 20mm) and TBGA64 (10 x 13mm, 1mm pitch) packages. The 8-bit Bus mode is only available when the M29DW128F is delivered in TSOP56 package. In order to meet environmental requirements, Numonyx offers the M29DW128F in ECOPACK® packages. ECOPACK packages are Lead-free. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. The memory is supplied with all the bits erased (set to '1').

Table 1. Signal names

A0-A22	Address Inputs
DQ0-DQ7	Data Inputs/Outputs
DQ8-DQ14	Data Inputs/Outputs
DQ15A-1	Data Input/Output or Address Input
Ē	Chip Enable
G	Output Enable
W	Write Enable
RP	Reset/Block Temporary Unprotect
RB	Ready/Busy Output
BYTE	Byte/Word Organization Select ⁽¹⁾
V _{CC}	Supply voltage
V _{PP} /WP	V _{PP} /Write Protect
V _{SS}	Ground
NC	Not Connected Internally

^{1.} The x8 organization is only available in TSOP56 Package while the x16 organization is available for both packages.

Figure 1. Logic diagram



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Table 2. **Bank architecture**

		Parar	neter Blocks	Main Blocks			
Bank	Bank size	No. of Blocks	Block size	No. of Blocks	Block size		
А	16 Mbit	8	8 Kbytes/ 4 KWords	31	64 Kbytes/ 32 KWords		
В	48 Mbit	_	_	96	64 Kbytes/ 32 KWords		
С	48 Mbit	_	_	96	64 Kbytes/ 32 KWords		
D	16 Mbit	8	8 Kbytes/ 4 KWords	31	64 Kbytes/ 32 KWords		

Figure 2. **TSOP** connections

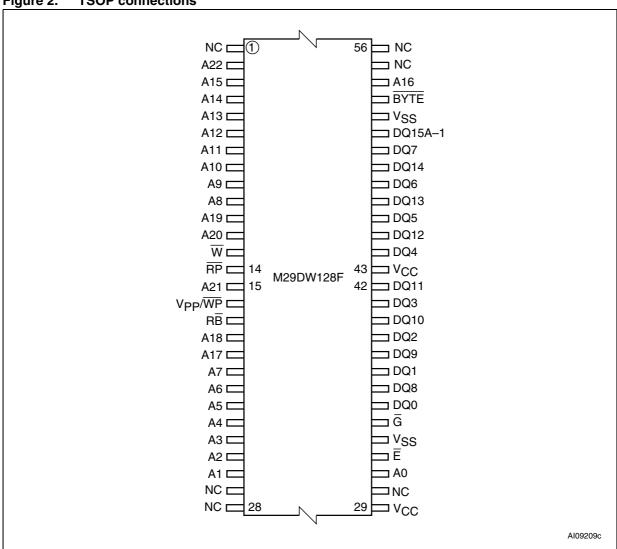
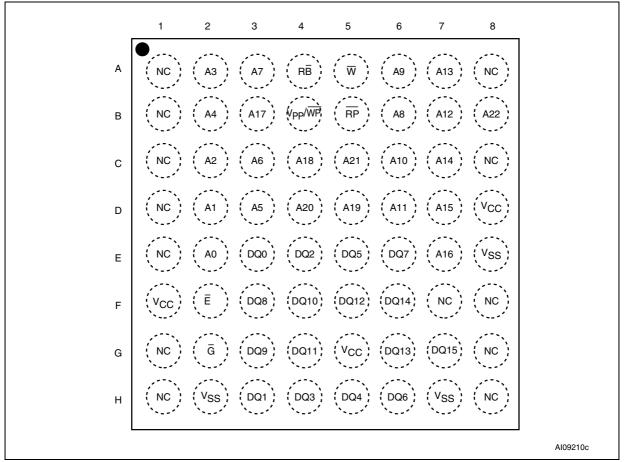
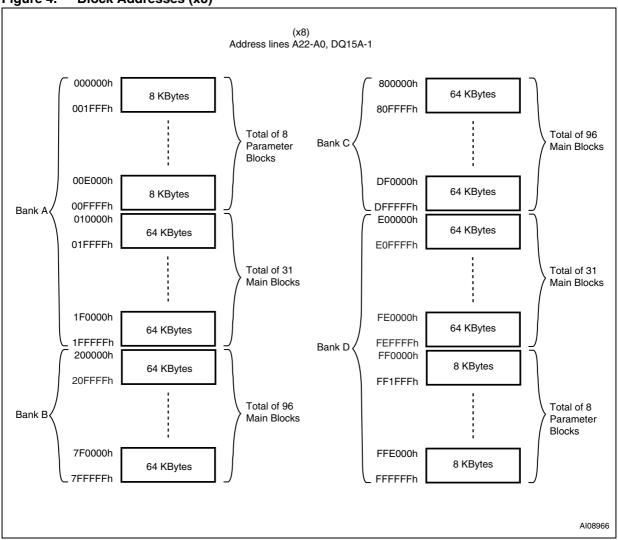


Figure 3. TBGA connections (top view through package)



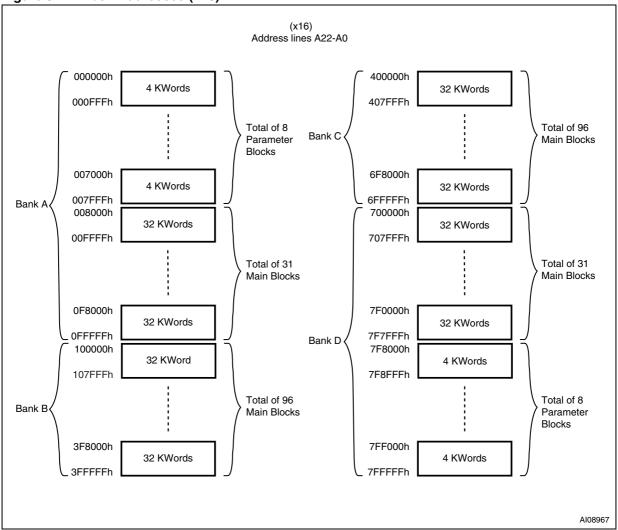
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Figure 4. Block Addresses (x8)



1. Also see Appendix A and Table 34 for a full listing of the Block Addresses.

Figure 5. Block Addresses (x16)



1. Also see Appendix A, Table 34 for a full listing of the Block Addresses.

Signal descriptions M29DW128F

2 Signal descriptions

See Figure 1: Logic diagram, and Table 1: Signal names, for a brief overview of the signals connected to this device.

2.1 Address Inputs (A0-A22)

The Address Inputs select the cells in the memory array to access during Bus Read operations. During Bus Write operations they control the commands sent to the Command Interface of the Program/Erase Controller.

2.2 Data Inputs/Outputs (DQ0-DQ7)

The Data I/O outputs the data stored at the selected address during a Bus Read operation. During Bus Write operations they represent the commands sent to the Command Interface of the internal state machine.

2.3 Data Inputs/Outputs (DQ8-DQ14)

The Data I/O outputs the data stored at the selected address during a Bus Read operation when $\overline{\text{BYTE}}$ is High, V_{IH} . When $\overline{\text{BYTE}}$ is Low, V_{IL} , these pins are not used and are high impedance. During Bus Write operations the Command Register does not use these bits. When reading the Status Register these bits should be ignored.

2.4 Data Input/Output or Address Input (DQ15A-1)

When the device is in x16 Bus mode, this pin behaves as a Data Input/Output pin (as DQ8-DQ14). When the device is in x8 Bus mode, this pin behaves as an address pin; DQ15A-1 Low will select the LSB of the addressed Word, DQ15A-1 High will select the MSB. Throughout the text consider references to the Data Input/Output to include this pin when the device operates in x16 bus mode and references to the Address Inputs to include this pin when the device operates in x8 bus mode except when stated explicitly otherwise.

2.5 Chip Enable (\overline{E})

The Chip Enable pin, \overline{E} , activates the memory, allowing Bus Read and Bus Write operations to be performed. When Chip Enable is High, V_{IH} , all other pins are ignored.

2.6 Output Enable (G)

The Output Enable pin, \overline{G} , controls the Bus Read operation of the memory.

M29DW128F Signal descriptions

2.7 Write Enable (\overline{W})

The Write Enable pin, \overline{W} , controls the Bus Write operation of the memory's Command Interface.

2.8 V_{PP/}Write Protect (V_{PP}/WP)

The V_{PP} /Write Protect pin provides two functions. The V_{PP} function allows the memory to use an external high voltage power supply to reduce the time required for Program operations. This is achieved by bypassing the unlock cycles and/or using the multiple Word (2 or 4 at-a-time) or multiple byte Program (2, 4 or 8 at-a-time) commands.

The Write Protect function provides a hardware method of protecting the four outermost boot blocks (two at the top, and two at the bottom of the address space). When V_{PP}/W rite Protect is Low, V_{IL} , the memory protects the four outermost boot blocks; Program and Erase operations in these blocks are ignored while V_{PP}/W rite Protect is Low, even when \overline{RP} is at V_{ID} .

When V_{PP} /Write Protect is High, V_{IH} , the memory reverts to the previous protection status of the four outermost boot blocks. Program and Erase operations can now modify the data in these blocks unless the blocks are protected using Block Protection.

Applying V_{PPH} to the V_{PP}/\overline{WP} pin will temporarily unprotect any block previously protected (including the four outermost parameter blocks) using a High Voltage Block Protection technique (In-System or Programmer technique). See *Table 9: Hardware Protection* for details.

When V_{PP} /Write Protect is raised to V_{PP} the memory automatically enters the Unlock Bypass mode. When V_{PP} /Write Protect returns to V_{IH} or V_{IL} normal operation resumes. During Unlock Bypass Program operations the memory draws I_{PP} from the pin to supply the programming circuits. See the description of the Unlock Bypass command in the Command Interface section. The transitions from V_{IH} to V_{PP} and from V_{PP} to V_{IH} must be slower than t_{VHVPP} see Figure~20.

Never raise V_{PP} /Write Protect to V_{PP} from any mode except Read mode, otherwise the memory may be left in an indeterminate state.

The V_{PP} /Write Protect pin must not be left floating or unconnected or the device may become unreliable. A 0.1 μ F capacitor should be connected between the V_{PP} /Write Protect pin and the V_{SS} Ground pin to decouple the current surges from the power supply. The PCB track widths must be sufficient to carry the currents required during Unlock Bypass Program, I_{PP}

Signal descriptions M29DW128F

2.9 Reset/Block Temporary Unprotect (RP)

The Reset/Block Temporary Unprotect pin can be used to apply a Hardware Reset to the memory or to temporarily unprotect all the blocks previously protected using a High Voltage Block Protection technique (In-System or Programmer technique).

Note that if V_{PP}/\overline{WP} is at V_{IL} , then the four outermost parameter blocks will remain protected even if \overline{RP} is at V_{ID} .

A Hardware Reset is achieved by holding Reset/Block Temporary Unprotect Low, V_{IL} , for at least t_{PLPX} . After Reset/Block Temporary Unprotect goes High, V_{IH} , the memory will be ready for Bus Read and Bus Write operations after t_{PHEL} or t_{RHEL} , whichever occurs last. See the Ready/Busy Output section, *Table 30: Reset/Block Temporary Unprotect AC characteristics* and *Figure 18* and *Figure 19* for more details.

Holding \overline{RP} at V_{ID} will temporarily unprotect all the blocks previously protected using a High Voltage Block Protection technique. Program and erase operations on all blocks will be possible. The transition from V_{IH} to V_{ID} must be slower than t_{PHPHH} .

2.10 Ready/Busy Output (RB)

The Ready/Busy pin is an open-drain output that can be used to identify when the device is performing a Program or erase operation. During Program or erase operations Ready/Busy is Low, V_{OL}. Ready/Busy is high-impedance during Read mode, Auto Select mode and Erase Suspend mode.

After a Hardware Reset, Bus Read and Bus Write operations cannot begin until Ready/Busy becomes high-impedance. See *Table 30: Reset/Block Temporary Unprotect AC characteristics* and *Figure 18* and *Figure 19*.

The use of an open-drain output allows the Ready/Busy pins from several memories to be connected to a single pull-up resistor. A Low will then indicate that one, or more, of the memories is busy.

2.11 Byte/Word Organization Select (BYTE)

It is used to switch between the x8 and x16 Bus modes of the memory when the M29DW128F is delivered in TSOP56 package. When Byte/Word Organization Select is Low, V_{IL} , the memory is in x8 mode, when it is High, V_{IH} , the memory is in x16 mode.

M29DW128F Signal descriptions

2.12 V_{CC} supply voltage (2.7V to 3.6V)

V_{CC} provides the power supply for all operations (Read, Program and Erase).

The Command Interface is disabled when the V_{CC} Supply Voltage is less than the Lockout Voltage, V_{LKO} . This prevents Bus Write operations from accidentally damaging the data during power up, power down and power surges. If the Program/Erase Controller is programming or erasing during this time then the operation aborts and the memory contents being altered will be invalid.

A $0.1\mu F$ capacitor should be connected between the V_{CC} Supply Voltage pin and the V_{SS} Ground pin to decouple the current surges from the power supply. The PCB track widths must be sufficient to carry the currents required during Program and erase operations, I_{CC2} .

2.13 V_{SS} Ground

 V_{SS} is the reference for all voltage measurements. The device features two V_{SS} pins both of which must be connected to the system ground.

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Bus operations M29DW128F

3 Bus operations

There are five standard bus operations that control the device. These are Bus Read (Random and Page modes), Bus Write, Output Disable, Standby and Automatic Standby.

Dual operations are possible in the M29DW128F, thanks to its multiple bank architecture. While programming or erasing in one banks, read operations are possible in any of the other banks. Write operations are only allowed in one bank at a time.

See *Table 3* and *Table 6*, Bus Operations, for a summary. Typically glitches of less than 5ns on Chip Enable, Write Enable, and Reset/Block Temporary Unprotect pins are ignored by the memory and do not affect bus operations.

3.1 Bus Read

Bus Read operations read from the memory cells, or specific registers in the Command Interface. To speed up the read operation the memory array can be read in Page mode where data is internally read and stored in a page buffer. The Page has a size of 8 Words and is addressed by the address inputs A0-A2.

A valid Bus Read operation involves setting the desired address on the Address Inputs, applying a Low signal, V_{IL} , to Chip Enable and Output Enable and keeping Write Enable High, V_{IH} . The Data Inputs/Outputs will output the value, see *Figure 12: Random Read AC waveforms*, *Figure 13: Page Read AC waveforms*, and *Table 26: Read AC characteristics*, for details of when the output becomes valid.

3.2 Bus Write

Bus Write operations write to the Command Interface. A valid Bus Write operation begins by setting the desired address on the Address Inputs. The Address Inputs are latched by the Command Interface on the falling edge of Chip Enable or Write Enable, whichever occurs last. The Data Inputs/Outputs are latched by the Command Interface on the rising edge of Chip Enable or Write Enable, whichever occurs first. Output Enable must remain High, V_{IH} , during the whole Bus Write operation. See *Figure 14* and *Figure 15*, Write AC Waveforms, and *Table 27* and *Table 28*, Write AC Characteristics, for details of the timing requirements.

3.3 Output Disable

The Data Inputs/Outputs are in the high impedance state when Output Enable is High, VIH.

3.4 Standby

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When Chip Enable is High, V_{IH} , the memory enters Standby mode and the Data Inputs/Outputs pins are placed in the high-impedance state. To reduce the Supply Current to the Standby Supply Current, I_{CC2} , Chip Enable should be held within $V_{CC} \pm 0.2V$. For the Standby current level see *Table 25: DC Characteristics*. During program or erase operations the memory will continue to use the Program/Erase Supply Current, I_{CC3} , for Program or Erase operations until the operation completes.

M29DW128F Bus operations

3.5 Automatic Standby

If CMOS levels ($V_{CC} \pm 0.2V$) are used to drive the bus and the bus is inactive for 300ns or more the memory enters Automatic Standby where the internal Supply Current is reduced to the Standby Supply Current, I_{CC2} . The Data Inputs/Outputs will still output data if a Bus Read operation is in progress.

3.6 Special Bus operations

Additional bus operations can be performed to read the Electronic Signature, verify the Protection Status of the Extended Memory Block (second section), and apply and remove Block Protection. These bus operations are intended for use by programming equipment and are not usually used in applications. They require V_{ID} to be applied to some pins.

3.6.1 Read Electronic Signature

The memory has two codes, the Manufacturer code and the Device code used to identify the memory. These codes can accessed by performing read operations with control signals and addresses set as shown in *Table 4* and *Table 6*. These codes can also be accessed by issuing an Auto Select command (see *Section 6.1.2: Auto Select command*).

3.6.2 Verify Extended Block Protection Indicator

The Extended Block is divided in two sections of which one is Factory Locked and the second one is either Customer Lockable or Customer Locked.

The Protection Status of the second section of the Extended Block (Customer Lockable or Customer Locked) can be accessed by reading the Extended Block Protection Indicator. This is performed by applying the signals as shown in *Table 5* and *Table 8*. The Protection Status of the Extended Block is then output on bits DQ7 and DQ6 of the Data Input/Outputs. (see *Table 3* and *Table 6*, Bus Operations).

The Protection Status of the Extended Block can also be accessed by issuing an Auto Select command (see *Section 6.1.2: Auto Select command*).

3.6.3 Verify Block Protection Status

The Protection Status of a Block can be directly accessed by performing a read operation with control signals and addresses set as shown in *Table 5* and *Table 8*. If the Block is protected, then 01h (in x8 mode) is output on Data Input/Outputs DQ0-DQ7, otherwise 00h is output.

3.6.4 Hardware Block Protect

The V_{PP}/\overline{WP} pin can be used to protect the four outermost parameter blocks. When V_{PP}/\overline{WP} is at V_{IL} the four outermost parameter blocks are protected and remain protected regardless of the Block Protection Status or the Reset/Block Temporary Unprotect pin state.

Bus operations M29DW128F

3.6.5 Temporary Unprotect of high voltage Protected Blocks

The $\overline{\mathsf{RP}}$ pin can be used to temporarily unprotect all the blocks previously protected using the In-System or the Programmer protection technique (High Voltage techniques). Refer to Section 2.9: Reset/Block Temporary Unprotect (RP).

Table 3. Bus operations, 8-bit mode⁽¹⁾

Operation	Ē	G	w	RP	V _{PP} /WP	Address Inputs	Data Inputs/Outputs		
Operation	-	G	, w	nr	V PP/ VV P	A22-A0, DQ15A-1	DQ14-DQ8	DQ7-DQ0	
Bus Read	V_{IL}	V_{IL}	V_{IH}	V_{IH}	V_{IH}	Cell Address	Hi-Z	Data Output	
Bus Write	V _{IL}	V_{IH}	V_{IL}	V_{IH}	V _{IH}	Command Address	Hi-Z	Data Input	
Output Disable	Х	V_{IH}	V_{IH}	V_{IH}	V _{IH}	Х	Hi-Z	Hi-Z	
Standby	V _{IH}	Χ	Х	V_{IH}	V _{IH}	Х	Hi-Z	Hi-Z	

^{1.} $X = V_{IL}$ or V_{IH} .

Table 4. Read Electronic Signature, 8-bit mode⁽¹⁾

Read Cycle	Ē	G	w	Address Inputs										Data Inputs/Outputs	
nead Cycle	_		W	A22-A10	А9	A8	A7-A6	A5-A4	А3	A2	A 1	A0	DQ15A-1	DQ14- DQ8	DQ7- DQ0
Manufacturer Code			V _{IH}	х	V _{ID}	х		Х	V_{IL}	V_{IL}	V_{IL}	V_{IL}	Х	Hi-Z	20h
Device Code (Cycle 1)	V.	V						V _{IL}	V_{IL}	V_{IL}	V_{IL}	V_{IH}	Х	Hi-Z	7Eh
Device Code (Cycle 2)	V _{IL}	V _{IL}					V _{IL}		V _{IH}	V_{IH}	V _{IH}	V_{IL}	Х	Hi-Z	20h
Device Code (Cycle 3)									V _{IH}	V _{IH}	V _{IH}	V _{IH}	Х	Hi-Z	00h

^{1.} $X = V_{IL}$ or V_{IH} .

Table 5. Block Protection, 8-bit mode⁽¹⁾

							Address Inputs										Data Inputs/Outputs		
Operation	E	G	w	RP	V _{PP} / WP	A22 - A12	A11- A10	A 9	A8	A 7	A 6	A5 - A4	A3- A2	A 1	A0	DQ15 A-1	DQ14 -DQ8	DQ7-DQ0	
Verify Extended Block Protection Indicator (bits DQ6, DQ7)	V _{IL}	V _{IL}	V _{IH}	V _{IH}	V _{IH}	ВА	Х	V _{ID}	x	x	V _{IL}	х	V _{IL}	V _{IH}	V _{IH}	х		80h (Customer Lockable) C0h (Customer Locked) ⁽²⁾	
Verify Block Protection Status						ВКА				V _{IL}		V _{IL}			V _{IL}	х	Hi-Z	01h (protected) 00h (unprotected)	
Temporary Block Unprotect ⁽³⁾	х	х	х	V _{ID}	х	Valid Data In							Data Input						

^{1.} $X = V_{IL}$ or V_{IH} . BKA Bank Address, BA any Address in the Block.

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^{2.} This indicates the protection status of the second section of the Extended Block; the first section of the Extended Block being always Factory Locked.

^{3.} The $\overline{\mathsf{RP}}$ pin unprotects all the blocks that have been previously protected using a High Voltage protection Technique.

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Table 6. Bus operations, 16-bit mode⁽¹⁾

Operation	E G		W	RP	V _{PP} /	Address Inputs	Data Inputs/Outputs
Operation		G	, vv	nr	WP	A22-A0	DQ15A-1, DQ14-DQ0
Bus Read	V_{IL}	V_{IL}	V_{IH}	V_{IH}	V_{IH}	Cell Address	Data Output
Bus Write	V _{IL}	V _{IH}	V_{IL}	V _{IH}	V _{IH}	Command Address	Data Input
Output Disable	Х	V_{IH}	V_{IH}	V_{IH}	V_{IH}	Х	Hi-Z
Standby	V _{IH}	Х	Х	V _{IH}	V _{IH}	Х	Hi-Z

^{1.} $X = V_{IL}$ or V_{IH} .

Table 7. Read Electronic Signature, 16-bit mode⁽¹⁾

								Data Inputs/Outputs					
Read Cycle	Ē	G	W	A22- A10	А9	A8	A7- A6	A5- A4	А3	A2	A 1	Α0	DQ15A-1, DQ14-DQ0
Manufacturer Code				×	V _{ID}	х	V _{IL}	Х	V_{IL}	V_{IL}	V_{IL}	V_{IL}	0020h
Device Code (Cycle 1)	V	V	V _{IH}						V _{IL}	V _{IL}	V _{IL}	V _{IH}	227Eh
Device Code (Cycle 2)	V _{IL}	V _{IL}						V_{IL}	V _{IH}	V _{IH}	V _{IH}	V _{IL}	2220h
Device Code (Cycle 3)									V_{IH}	V _{IH}	V _{IH}	V_{IH}	2200h

^{1.} $X = V_{IL}$ or V_{IH} .

Table 8. Block Protection, 16-bit mode⁽¹⁾

					v ,				Add	Iress	Inpu	ts				Data Inputs/Outputs	
Operation	Ē	G	W	RP	V _{PP} / WP	A22- A12	A11- A10	А9	A 8	A 7	A 6	A5- A4	A3- A2	A 1	A0	DQ15A-1, DQ14-DQ0	
Verify Extended Block Indicator (bits DQ6, DQ7)	V _{IL}	V _{IL}	V _{IH}	V _{IH}	V _{IH}	ВА	x	V _{ID}	х	х	V_{IL}	х	V _{IL}	V _{IH}	V _{IH}	0080h (Customer Lockable) 00C0h (Customer Locked) ⁽²⁾	
Verify Block Protection Status						ВКА				V _{IL}		V _{IL}			V _{IL}	0001h (protected) 0000h (unprotected)	
Temporary Block Unprotect ⁽³⁾	Х	Х	Х	V_{ID}	х	Valid									Data Input		

^{1.} $X = V_{IL}$ or V_{IH} . BKA Bank Address, BA Any Address in the Block.

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^{2.} This indicates the protection status of the second section of the Extended Block; the first section of the Extended Block being always Factory Locked.

^{3.} The $\overline{\mathsf{RP}}$ pin unprotects all the blocks that have been previously protected using a High Voltage protection Technique.

Hardware Protection M29DW128F

4 Hardware Protection

The M29DW128F features hardware protection/unprotection. Refer to *Table 9* for details on hardware block protection/unprotection using V_{PP}/\overline{WP} and \overline{RP} pins.

4.1 Write Protect

The V_{PP}/\overline{WP} pin protects the four outermost parameter blocks (refer to Section 2: Signal descriptions for a detailed description of the signals).

4.2 Temporary Block Unprotect

When held at V_{ID} , the Reset/Block Temporary Unprotect pin, \overline{RP} , will temporarily unprotect all the blocks previously protected using a High Voltage Block Protection technique.

Table 9. Hardware Protection

V _{PP} /WP	RP	Function
V	V _{IH}	4 outermost parameter blocks protected from Program/Erase operations
V _{IL}	V _{ID}	All blocks temporarily unprotected except the 4 outermost blocks ⁽¹⁾
V _{IH} or V _{ID}	V _{ID}	All blocks temporarily unprotected ⁽¹⁾
V _{PPH}	V _{IH} or V _{ID}	All blocks temporarily unprotected ⁽¹⁾

The temporary unprotection is valid only for the blocks that have been protected using the High Voltage Protection Technique (see Appendix D: High Voltage Block Protection). The blocks protected using a software protection method (Standard, Password) do not follow this rules.

M29DW128F Software Protection

5 Software Protection

The M29DW128F has two different Software Protection modes: the Standard Protection mode and the Password Protection mode.

On first use all parts default to the Standard Protection mode and the customer is free to activate the Standard or the Password Protection mode.

The desired protection mode is activated by setting one of two one-time programmable bits, the Standard Protection Mode Lock bit or the Password Protection Mode Lock bit. Programming the Standard and the Password Protection Mode Lock bit to '1' will permanently activate the Standard Protection mode and the Password Protection mode, respectively. These two bits are one-time programmable and non-volatile, once the Protection mode has been programmed, it cannot be changed and the device will permanently operate in the selected Protection mode. It is recommended to activate the desired Software Protection mode when first programming the device.

The device is shipped with all blocks unprotected. The Block Protection Status can be read by issuing the Auto Select command (see *Table 10: Block Protection status*).

The Standard and Password Protection modes offer two levels of protection, a Block Lock/Unlock protection and a Non-Volatile protection.

For the four outermost parameter blocks, an even higher level of block protection can be achieved by locking the blocks using the Non-Volatile Protection and then by holding the V_{PP}/\overline{WP} pin Low.

5.1 Standard Protection mode

5.1.1 Block Lock/Unlock Protection

It is a flexible mechanism to protect/unprotect a block or a group of blocks from program or erase operations.

A volatile Lock bit is assigned to each block or group of blocks. When the lock bit is set to '1' the associated block or group of blocks is protected from program/erase operations, when the Lock bit is set to '0' the associated block or group of blocks is unprotected and can be programmed or erased.

The Lock bits can be set ('1') and cleared ('0') individually as often as required by issuing a Set Lock Bit command and Clear Lock bit command, respectively.

After a Power-up or Hardware Reset, all the Lock bits are cleared to '0' (block unlocked).

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5.1.2 Non-Volatile Protection

A Non-Volatile Modify Protection bit is assigned to each block or group of blocks.

When a Non-Volatile Modify Protection bit is set to '1' the associated block or group of blocks is protected, preventing any program or erase operations in this block or group of blocks.

The Non-Volatile Modify Protection bits are set individually by issuing a Set Non-Volatile Modify Protection bit command. They are non-volatile and will remain set through a hardware reset or a power-down/power-up sequence.

The Non-Volatile Modify Protection bits cannot be cleared individually, they can only be cleared all at the same time by issuing a Clear Non-Volatile Modify Protection bits command.

However if any one of the Non-Volatile Modify Protection bits has to be cleared, care should be taken to preprogram to '1' all the Non-Volatile Modify Protection bits prior to issuing the Clear Non-Volatile Modify Protection bits in order to prevent the over-erasure of previously cleared Non Volatile Modify Protection bits. It is crucial to prevent over-erasure because the process may lead to permanent damage to the Non-Volatile Modify Protection bits and the device does not have any built-in means of preventing over-erasure.

The device features a volatile Lock-Down bit which can be used to prevent changing the state of the Non-Volatile Modify Protection bits. When set to '1', the Non-Volatile Modify Protection bits can no longer be modified; when set to '0', the Non-Volatile Modify Protection bits can be set and reset using the Set Non-Volatile Modify Protection bit command and the Clear Non-Volatile Modify Protection bits command, respectively.

The Lock-Down bit is set by issuing the Set Lock-Down bit Command. It is not cleared using a command, but through a hardware reset or a power-down/power-up sequence.

The parts are shipped with the Non-Volatile Modify Protection bits set to '0'.

Locked blocks and Non-Volatile Locked blocks can co-exist in the same memory array.

Refer to *Table 10: Block Protection status* and *Figure 7: Software Protection scheme* for details on the block protection mechanism.

5.2 Password Protection mode

The Password Protection mode provides a more advanced level of software protection than the Standard Protection mode.

Prior to entering the Password Protection mode, it is necessary to set a password and to verify it (see Section 6.3.5: Password Program command and Section 6.3.6: Password Verify command). The Password Protection mode is then activated by programming the Password Protection Mode Lock bit to '1'. The Reset/Block Temporary Unprotect pin, $\overline{\text{RP}}$, can be at V_{ID} or at V_{IH} .

This operation is not reversible and once the bit is programmed the device will permanently remain in the Password Protection mode.

The Password Protection mode uses the same protection mechanisms as the Standard Protection mode (Block Lock/Unlock, Non-Volatile Protection).

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5.2.1 Block Lock/Unlock Protection

The Block Lock/Unlock Protection operates exactly in the same way as in the Standard Protection mode.

5.2.2 Non-Volatile Protection

The Non-Volatile Protection is more advanced in the Password Protection mode.

In this mode, the Lock-Down bit cannot be cleared through a hardware reset or a power-down/power-up sequence.

The Lock-Down bit is cleared by issuing the Password Protection Unlock command along with the correct password.

Once the correct Password has been provided, the Lock-Down bit is cleared and the Non-Volatile Modify Protection bits can be set or reset using the appropriate commands (the Set Non-Volatile Modify Protection bit command or the Clear Non-Volatile Modify Protection bits command, respectively).

If the Password provided is not correct, the Lock-Down bit remains locked and the state of the Non-Volatile Modify Protection bits cannot be modified.

The Password is a 64-bit code located in the memory space. It must be programmed by the user prior to selecting the Password Protection mode. The Password is programmed by issuing a Password Program command and checked by issuing a Password Verify command. The Password should be unique for each part.

Once the device is in Password Protection mode, the Password can no longer be read or retrieved. Moreover, all commands to the address where the password is stored, are disabled. Refer to *Table 10: Block Protection status* and *Figure 7: Software Protection scheme* for details on the block protection scheme.

Table 10. Block Protection status

Volatile Lock bit	Non-Volatile Modify Protection bit	Lock-Down bit	Block Protection status		Block Protection status				
0	0	0	00h	Block	Non-Volatile Modify Protection bit can be modified ⁽¹⁾				
0	0	1	0011	Unprotected	Non-Volatile Modify Protection bit cannot be modified ⁽¹⁾				
0	1	0	Protection						
1	0	0		Block	Non-Volatile Modify Protection bit can be modified ⁽¹⁾				
1	1	0	01h	Program/					
0	1	1	OIII	Erase Protected					
1	0	1	- 01h	i iolecieu	Non-Volatile Modify Protection bit cannot be modified ⁽¹⁾				
1	1	1							

The Lock bit can always be modified by issuing a Clear Lock bit command or by taking the device through a Power-up or Hardware Reset.

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Figure 6. Block Protection State diagram

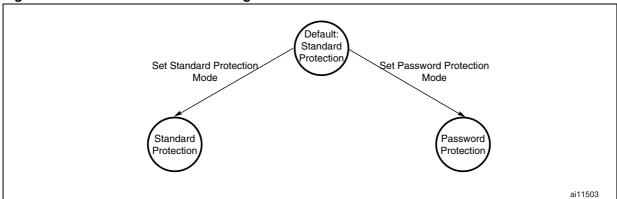
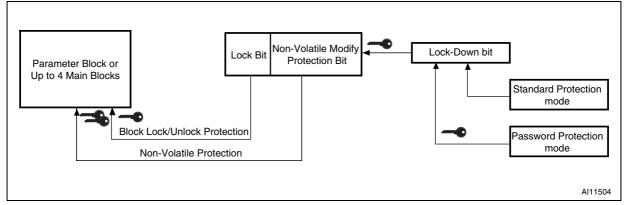


Figure 7. Software Protection scheme



M29DW128F Command interface

6 Command interface

All Bus Write operations to the memory are interpreted by the Command Interface. Commands consist of one or more sequential Bus Write operations. Failure to observe a valid sequence of Bus Write operations will result in the memory returning to Read mode. The long command sequences are imposed to maximize data security.

The address used for the commands changes depending on whether the memory is in 16-bit or 8-bit mode.

6.1 Standard commands

See either *Table 12*, or *Table 11*, depending on the configuration that is being used, for a summary of the Standard commands.

6.1.1 Read/Reset command

The Read/Reset command returns the memory to Read mode. It also resets the errors in the Status Register. Either one or three Bus Write operations can be used to issue the Read/Reset command.

The Read/Reset command can be issued, between Bus Write cycles before the start of a program or erase operation, to return the device to Read mode. If the Read/Reset command is issued during the time-out of a Block erase operation, the memory will take up to 10µs to abort. During the abort period no valid data can be read from the memory.

The Read/Reset command will not abort an Erase operation when issued while in Erase Suspend.

6.1.2 Auto Select command

The Auto Select command is used to read the Manufacturer Code, the Device Code, the Protection Status of each block (Block Protection Status) and the Extended Block Protection Indicator. It can be addressed to either Bank.

Three consecutive Bus Write operations are required to issue the Auto Select command. Once the Auto Select command is issued Bus Read operations to specific addresses output the Manufacturer Code, the Device Code, the Extended Block Protection Indicator and a Block Protection Status (see *Table 11* and *Table 12* in conjunction with *Table 4*, *Table 5*, *Table 7* and *Table 8*). The memory remains in Auto Select mode until a Read/Reset or CFI Query command is issued.

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6.1.3 Read CFI Query command

The Read CFI Query Command is used to put the addressed bank in Read CFI Query mode. Once in Read CFI Query mode Bus Read operations to the same bank will output data from the Common Flash Interface (CFI) Memory Area. If the read operations are to a different bank from the one specified in the command then the read operations will output the contents of the memory array and not the CFI data.

One Bus Write cycle is required to issue the Read CFI Query Command. Care must be taken to issue the command to one of the banks (A22-A19) along with the address shown in *Table 3* and *Table 6*. Once the command is issued subsequent Bus Read operations in the same bank (A22-A19) to the addresses shown in *Appendix B: Common Flash Interface (CFI)* (A7-A0), will read from the Common Flash Interface Memory Area.

This command is valid only when the device is in the Read Array or Auto Select mode. To enter Read CFI query mode from Auto Select mode, the Read CFI Query command must be issued to the same bank address as the Auto Select command, otherwise the device will not enter Read CFI Query mode.

The Read/Reset command must be issued to return the device to the previous mode (the Read Array mode or Auto Select mode). A second Read/Reset command is required to put the device in Read Array mode from Auto Select mode.

See Appendix B, Table 35, Table 36, Table 37, Table 38, Table 39 and Table 40 for details on the information contained in the Common Flash Interface (CFI) memory area.

6.1.4 Blank Verify command

The Blank Verify command is used to check if a block is blank or in other words, if it has been successfully erased and all its bits set to '1'. Three cycles are required to issue a Verify command:

- 1. The command starts with two unlock cycles.
- The third bus write cycle sets up the Verify command code along with the address of the block to be checked.
- 3. Bus Read operations during the Blank Verify operation output the Status Register on Data Inputs/Outputs (see *7: Status Register*).

After the Blank Verify command has completed, the memory returns to Read mode, unless an error has occurred. When an error occurs, the memory continues to output the Status Register. A Read/Reset command must be issued to reset the error condition and return to Read mode.F

6.1.5 Chip Erase command

The Chip Erase command can be used to erase the entire chip. Six Bus Write operations are required to issue the Chip Erase Command and start the Program/Erase Controller.

If any blocks are protected, then these are ignored and all the other blocks are erased. If all of the blocks are protected the Chip Erase operation appears to start but will terminate within about 100µs, leaving the data unchanged. No error condition is given when protected blocks are ignored.

During the erase operation the memory will ignore all commands, including the Erase Suspend command. It is not possible to issue any command to abort the operation. Typical chip erase times are given in *Table 18*. All Bus Read operations during the Chip Erase

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operation will output the Status Register on the Data Inputs/Outputs. See the section on the Status Register for more details.

After the Chip Erase operation has completed the memory will return to the Read mode, unless an error has occurred. When an error occurs the memory will continue to output the Status Register. A Read/Reset command must be issued to reset the error condition and return to Read mode.

The Chip Erase Command sets all of the bits in unprotected blocks of the memory to '1'. All previous data is lost.

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6.1.6 Block Erase command

The Block Erase command can be used to erase a list of one or more blocks in one or more Banks. It sets all of the bits in the unprotected selected blocks to '1'. All previous data in the selected blocks is lost.

Six Bus Write operations are required to select the first block in the list. Each additional block in the list can be selected by repeating the sixth Bus Write operation using the address of the additional block. The Block Erase operation starts the Program/Erase Controller after a time-out period of 50µs after the last Bus Write operation. Once the Program/Erase Controller starts it is not possible to select any more blocks. Each additional block must therefore be selected within 50µs of the last block. The 50µs timer restarts when an additional block is selected. After the sixth Bus Write operation a Bus Read operation within the same Bank will output the Status Register. See the Status Register section for details on how to identify if the Program/Erase Controller has started the Block Erase operation.

If any selected blocks are protected then these are ignored and all the other selected blocks are erased. If all of the selected blocks are protected the Block Erase operation appears to start but will terminate within about 100µs, leaving the data unchanged. No error condition is given when protected blocks are ignored.

During the Block Erase operation the memory will ignore all commands except the Erase Suspend command and the Read/Reset command which is only accepted during the 50µs time-out period. Typical block erase times are given in *Table 18*.

After the Erase operation has started all Bus Read operations to the Banks being erased will output the Status Register on the Data Inputs/Outputs. See the section on the Status Register for more details.

After the Block Erase operation has completed the memory will return to the Read mode, unless an error has occurred.

When an error occurs, Bus Read operations to the Banks where the command was issued will continue to output the Status Register. A Read/Reset command must be issued to reset the error condition and return to Read mode.

6.1.7 Erase Suspend command

The Erase Suspend command may be used to temporarily suspend a Block or multiple Block Erase operation. One Bus Write operation specifying the Bank Address of one of the Blocks being erased is required to issue the command. Issuing the Erase Suspend command returns the whole device to Read mode.

The Program/Erase Controller will suspend within the Erase Suspend Latency time (see *Table 18* for value) of the Erase Suspend Command being issued. Once the Program/Erase Controller has stopped the memory will be set to Read mode and the Erase will be suspended. If the Erase Suspend command is issued during the period when the memory is waiting for an additional block (before the Program/Erase Controller starts) then the Erase is suspended immediately and will start immediately when the Erase Resume Command is issued. It is not possible to select any further blocks to erase after the Erase Resume.

During Erase Suspend it is possible to Read and Program cells in blocks that are not being erased; both Read and Program operations behave as normal on these blocks. If any attempt is made to program in a protected block or in the suspended block then the Program command is ignored and the data remains unchanged. The Status Register is not read and no error condition is given. Reading from blocks that are being erased will output the Status Register.

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It is also possible to issue the Auto Select, Read CFI Query and Unlock Bypass commands during an Erase Suspend. The Read/Reset command must be issued to return the device to Read Array mode before the Resume command will be accepted.

During Erase Suspend a Bus Read operation to the Extended Block will output the Extended Block data. Once in the Extended Block mode, the Exit Extended Block command must be issued before the erase operation can be resumed.

6.1.8 Erase Resume command

The Erase Resume command is used to restart the Program/Erase Controller after an Erase Suspend. The command must include the Bank Address of the Erase-Suspended Bank, otherwise the Program/Erase Controller is not restarted.

The device must be in Read Array mode before the Resume command will be accepted. An Erase can be suspended and resumed more than once.

6.1.9 Program Suspend command

The Program Suspend command allows the system to interrupt a program operation so that data can be read from any block. When the Program Suspend command is issued during a program operation, the device suspends the program operation within the Program Suspend Latency time (see *Table 18* for value) and updates the Status Register bits. The Bank Addresses of the Block being programmed must be specified in the Program Suspend command.

After the program operation has been suspended, the system can read array data from any address. However, data read from Program-Suspended addresses is not valid.

The Program Suspend command may also be issued during a program operation while an erase is suspended. In this case, data may be read from any addresses not in Erase Suspend or Program Suspend. If a read is needed from the Extended Block area (One-time Program area), the user must use the proper command sequences to enter and exit this region.

The system may also issue the Auto Select command sequence when the device is in the Program Suspend mode. The system can read as many Auto Select codes as required. When the device exits the Auto Select mode, the device reverts to the Program Suspend mode, and is ready for another valid operation. See Auto Select command sequence for more information.

6.1.10 Program Resume command

After the Program Resume command is issued, the device reverts to programming. The controller can determine the status of the program operation using the DQ7 or DQ6 status bits, just as in the standard program operation. See Write Operation Status for more information.

The system must write the Program Resume command, specifying the Bank addresses of the Program-Suspended Block, to exit the Program Suspend mode and to continue the programming operation.

Further issuing of the Resume command is ignored. Another Program Suspend command can be written after the device has resumed programming.

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6.1.11 Program command

The Program command can be used to program a value to one address in the memory array at a time. The command requires four Bus Write operations, the final Write operation latches the address and data in the internal state machine and starts the Program/Erase Controller.

Programming can be suspended and then resumed by issuing a Program Suspend command and a Program Resume command, respectively (see *Section 6.1.9: Program Suspend command* and *Section 6.1.10: Program Resume command* paragraphs).

If the address falls in a protected block then the Program command is ignored, the data remains unchanged. The Status Register is never read and no error condition is given.

After programming has started, Bus Read operations in the Bank being programmed output the Status Register content, while Bus Read operations to the other Bank output the contents of the memory array. See the section on the Status Register for more details. Typical program times are given in *Table 18*.

After the program operation has completed the memory will return to the Read mode, unless an error has occurred. When an error occurs Bus Read operations to the Bank where the command was issued will continue to output the Status Register. A Read/Reset command must be issued to reset the error condition and return to Read mode.

One of the Erase Commands must be used to set all the bits in a block or in the whole memory from '0' to '1'.

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Table 11. Standard Commands, 8-bit mode⁽¹⁾⁽²⁾

				Bus operations													
Command		ength	1st		21	2nd		3rd		4th		5th		th			
			Add	Data	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data			
Read/Res	ret.	1	Х	F0													
rieau/ries	9 6 1	3	AAA	AA	555	55	Х	F0									
	Manufacturer Code																
A 4 =	Device Code						(BKA)										
Auto Select	Extended Block Protection Indicator	3	AAA	AA	555	55	AAA	90	(3)	(3)							
	Block Protection Status																
Program	<u> </u>	4	AAA	AA	555	55	AAA	A0	PA	PD							
Blank Ver	ify Command	3	AAA	AA	555	55	ВА	ВС									
Verify		3	AAA	AA	555	55	ВА	вс									
Chip Eras	se	6	AAA	AA	555	55	AAA	80	AAA	AA	555	55	AAA	10			
Block Erase		6+	AAA	AA	555	55	AAA	80	AAA	AA	555	55	ВА	30			
Erase/Program Suspend		1	BKA	В0													
Erase/Program Resume		1	BKA	30													
Read CFI	Query	1	(BKA) AAA	98													

^{1.} Grey cells represent Read cycles. The other cells are Write cycles.

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^{2.} X Don't Care, PA Program Address, PD Program Data, BA Any address in the Block, BKA Bank Address. All values in the table are in hexadecimal.

^{3.} The Auto Select addresses and data are given in *Table 4: Read Electronic Signature, 8-bit mode*, and *Table 5: Block Protection, 8-bit mode*, except for A9 that is 'Don't Care'.

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Table 12. Standard Commands, 16-bit mode⁽¹⁾⁽²⁾

		_	Bus operations												
Command		Length	1st		21	nd	3rd		4th		5th		6th		
		_	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data	
Pond/Pont		1	Χ	F0											
Read/Reset		3	555	AA	2AA	55	Х	F0							
	Manufacturer Code														
	Device Code	3		АА	2AA	55	(BKA) 555	90	(3)	(3)					
Auto Select	Extended Block Protection Indicator		555												
	Block Protection Status														
Program		4	555	AA	2AA	55	555	A0	PA	PD					
Blank Verify	Command	3	555	AA	2AA	55	ВА	ВС							
Verify		3	555	AA	2AA	55	ВА	ВС							
Chip Erase		6	555	AA	2AA	55	555	80	555	AA	2AA	55	555	10	
Block Erase		6+	555	AA	2AA	55	555	80	555	AA	2AA	55	ВА	30	
Erase/Program Suspend		1	BKA	В0											
Erase/Program Resume		1	BKA	30											
Read CFI Query		1	(BKA) 555	98											

^{1.} Grey cells represent Read cycles. The other cells are Write cycles.

^{2.} X Don't Care, PA Program Address, PD Program Data, BA Any address in the Block, BKA Bank Address. All values in the table are in hexadecimal.

^{3.} The Auto Select addresses and data are given in *Table 7: Read Electronic Signature, 16-bit mode*, and *Table 8: Block Protection, 16-bit mode*, except for A9 that is 'Don't Care'.

M29DW128F Command interface

6.2 Fast Program commands

The M29DW128F offers a set of Fast Program commands to improve the programming throughput:

- Write to Buffer and Program
- Double and Quadruple Word, Program
- Double, Quadruple and Octuple Byte Program
- Unlock Bypass.

See either *Table 14*, or *Table 13*, depending on the configuration that is being used, for a summary of the Fast Program commands.

When V_{PPH} is applied to the V_{PP} /Write Protect pin the memory automatically enters the Fast Program mode. The user can then choose to issue any of the Fast Program commands. Care must be taken because applying a V_{PPH} to the V_{PP} /WP pin will temporarily unprotect any protected block.

Only one bank can be programmed at any one time. The other bank must be in Read mode or Erase Suspend.

After programming has started, Bus Read operations in the Bank being programmed output the Status Register content, while Bus Read operations to the other Bank output the contents of the memory array. Fast program commands can be suspended and then resumed by issuing a Program Suspend command and a Program Resume command, respectively (see Section 6.1.9: Program Suspend command and Section 6.1.10: Program Resume command paragraphs.)

After the fast program operation has completed, the memory will return to the Read mode, unless an error has occurred. When an error occurs Bus Read operations to the Bank where the command was issued will continue to output the Status Register. A Read/Reset command must be issued to reset the error condition and return to Read mode. One of the Erase Commands must be used to set all the bits in a block or in the whole memory from '0' to '1'.

Typical Program times are given in *Table 18: Program, Erase Times and Program, Erase Endurance Cycles*.

Command interface M29DW128F

6.2.1 Write to Buffer and Program command

The Write to Buffer and Program Command makes use of the device's 64-byte Write Buffer to speed up programming. 32 Words/64 bytes can be loaded into the Write Buffer. Each Write Buffer has the same A5-A22 addresses. The Write to Buffer and Program command dramatically reduces system programming time compared to the standard non-buffered Program command.

When issuing a Write to Buffer and Program command, the V_{PP}/\overline{WP} pin can be either held High, V_{IH} or raised to V_{PPH} .

See Table 18 for details on typical Write to Buffer and Program times in both cases.

Five successive steps are required to issue the Write to Buffer and Program command:

- The Write to Buffer and Program command starts with two unlock cycles.
- 2. The third Bus Write cycle sets up the Write to Buffer and Program command. The setup code can be addressed to any location within the targeted block.
- 3. The fourth Bus Write cycle sets up the number of Words/bytes to be programmed. Value N is written to the same block address, where N+1 is the number of Words/bytes to be programmed. N+1 must not exceed the size of the Write Buffer or the operation will abort.
- 4. The fifth cycle loads the first address and data to be programmed.
- 5. Use N Bus Write cycles to load the address and data for each Word/bytes into the Write Buffer. Addresses must lie within the range from the start address+1 to the start address + N-1. Optimum performance is obtained when the start address corresponds to a 64 byte boundary. If the start address is not aligned to a 64 byte boundary, the total programming time is doubled.

All the addresses used in the Write to Buffer and Program operation must lie within the same page.

To program the content of the Write Buffer, this command must be followed by a Write to Buffer and Program Confirm command.

If an address is written several times during a Write to Buffer and Program operation, the address/data counter will be decremented at each data load operation and the data will be programmed to the last word loaded into the Buffer.

Invalid address combinations or failing to follow the correct sequence of Bus Write cycles will abort the Write to Buffer and Program.

The Status Register bits DQ1, DQ5, DQ6, DQ7 can be used to monitor the device status during a Write to Buffer and Program operation.

If is not possible to detect Program operation fails when changing programmed data from '0' to '1', that is when reprogramming data in a portion of memory already programmed. The resulting data will be the logical OR between the previous value and the current value.

A Write to Buffer and Program Abort and Reset command must be issued to abort the Write to Buffer and Program operation and reset the device in Read mode.

During Write to Buffer and Program operations, the bank being programmed will accept Program/Erase Suspend commands.

See Appendix E, Figure 27: Write to Buffer and Program flowchart and Pseudo Code, for a suggested flowchart on using the Write to Buffer and Program command.

6.2.2 Write to Buffer and Program Confirm command

The Write to Buffer and Program Confirm command is used to confirm a Write to Buffer and Program command and to program the N+1 Words/bytes loaded in the Write Buffer by this command.

6.2.3 Write to Buffer and Program Abort and Reset command

The Write to Buffer and Program Abort and Reset command is used to abort Write to Buffer and Program command.

6.2.4 Double Word Program command

This is used to write two adjacent Words in x16 mode, simultaneously. The addresses of the two Words must differ only in A0.

Three bus write cycles are necessary to issue the command:

- 1. The first bus cycle sets up the command.
- 2. The second bus cycle latches the Address and the Data of the first Word to be written.
- 3. The third bus cycle latches the Address and the Data of the second Word to be written and starts the Program/Erase Controller.

6.2.5 Quadruple Word Program command

This is used to write a page of four adjacent Words, in x16 mode, simultaneously. The addresses of the four Words must differ only in A1 and A0.

Five bus write cycles are necessary to issue the command:

- 1. The first bus cycle sets up the command.
- 2. The second bus cycle latches the Address and the Data of the first Word to be written.
- 3. The third bus cycle latches the Address and the Data of the second Word to be written.
- 4. The fourth bus cycle latches the Address and the Data of the third Word to be written.
- 5. The fifth bus cycle latches the Address and the Data of the fourth Word to be written and starts the Program/Erase Controller.

6.2.6 Double byte Program Command

This is used to write two adjacent bytes in x8 mode, simultaneously. The addresses of the two bytes must differ only in DQ15A-1.

Three bus write cycles are necessary to issue the command:

- The first bus cycle sets up the command.
- 2. The second bus cycle latches the Address and the Data of the first byte to be written.
- 3. The third bus cycle latches the Address and the Data of the second byte to be written and starts the Program/Erase Controller.

6.2.7 Quadruple byte Program command

This is used to write four adjacent bytes in x8 mode, simultaneously. The addresses of the four bytes must differ only in A0, DQ15A-1.

Five bus write cycles are necessary to issue the command.

- 1. The first bus cycle sets up the command.
- 2. The second bus cycle latches the Address and the Data of the first byte to be written.
- 3. The third bus cycle latches the Address and the Data of the second byte to be written.
- 4. The fourth bus cycle latches the Address and the Data of the third byte to be written.
- 5. The fifth bus cycle latches the Address and the Data of the fourth byte to be written and starts the Program/Erase Controller.

6.2.8 Octuple byte Program command

This is used to write eight adjacent bytes, in x8 mode, simultaneously. The addresses of the eight bytes must differ only in A1, A0 and DQ15A-1.

Nine bus write cycles are necessary to issue the command:

- 1. The first bus cycle sets up the command.
- 2. The second bus cycle latches the Address and the Data of the first byte to be written.
- 3. The third bus cycle latches the Address and the Data of the second byte to be written.
- 4. The fourth bus cycle latches the Address and the Data of the third byte to be written.
- 5. The fifth bus cycle latches the Address and the Data of the fourth byte to be written.
- 6. The sixth bus cycle latches the Address and the Data of the fifth byte to be written.
- 7. The seventh bus cycle latches the Address and the Data of the sixth byte to be written.
- 8. The eighth bus cycle latches the Address and the Data of the seventh byte to be written.
- 9. The ninth bus cycle latches the Address and the Data of the eighth byte to be written and starts the Program/Erase Controller.

6.2.9 Unlock Bypass command

The Unlock Bypass command is used in conjunction with the Unlock Bypass Program command to program the memory faster than with the standard program commands. When the cycle time to the device is long, considerable time saving can be made by using these commands. Three Bus Write operations are required to issue the Unlock Bypass command.

Once the Unlock Bypass command has been issued the bank enters Unlock Bypass mode. When in Unlock Bypass mode, only the Unlock Bypass Program and Unlock Bypass Reset commands are valid. The Unlock Bypass Program command can then be issued to program addresses within the bank, or the Unlock Bypass Reset command can be issued to return the bank to Read mode. In Unlock Bypass mode the memory can be read as if in Read mode.

6.2.10 Unlock Bypass Program command

The Unlock Bypass Program command can be used to program one address in the memory array at a time. The command requires two Bus Write operations, the final write operation latches the address and data and starts the Program/Erase Controller.

The Program operation using the Unlock Bypass Program command behaves identically to the Program operation using the Program command. The operation cannot be aborted, a Bus Read operation to the Bank where the command was issued outputs the Status Register. See the Program command for details on the behavior.

6.2.11 Unlock Bypass Reset command

The Unlock Bypass Reset command can be used to return to Read/Reset mode from Unlock Bypass mode. Two Bus Write operations are required to issue the Unlock Bypass Reset command. Read/Reset command does not exit from Unlock Bypass mode.

Table 13. Fast Program Commands, 8-bit mode⁽¹⁾

			Ogia				<u>, </u>			Write	operat	ions							
Command	Length	1	st	2	nd	3	rd	4	th	5	th	6	th	7	th	8	th	9	th
	7	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data
Write to Buffer and Program	N + 5	AAA	AA	555	55	ВА	25	ВА	N ⁽²⁾	PA (3)	PD	WBL (4)	PD						
Write to Buffer and Program Abort and Reset	3	AAA	AA	555	55	AAA	F0												
Write to Buffer and Program Confirm	1	BA (5)	29																
Double byte Program	3	AAA	50	PA0	PD0	PA1	PD1												
Quadruple byte Program	5	AAA	56	PA0	PD0	PA1	PD1	PA2	PD2	PA3	PD3								
Octuple byte Program	9	AAA	8B	PA0	PD0	PA1	PD1	PA2	PD2	PA3	PD3	PA4	PD4	PA5	PD5	PA6	PD6	PA7	PD7
Unlock Bypass	3	AAA	AA	555	55	AAA	20												
Unlock Bypass Program	2	Х	A0	PA	PD														
Unlock Bypass Reset	2	Х	90	х	00														

X Don't Care, PA Program Address, PD Program Data, BA Any address in the Block, BKA Bank Address, WBL Write Buffer Location. All values in the table are in hexadecimal.

^{2.} The maximum number of cycles in the command sequence is 68. N+1 is the number of bytes to be programmed during the Write to Buffer and Program operation.

^{3.} Each buffer has the same A5-A22 addresses. A0-A4 and A-1 are used to select a byte within the N+1 byte page.

^{4.} The 6th cycle has to be issued N time. WBL scans the byte inside the page.

^{5.} BA must be identical to the address loaded during the Write to buffer and Program 3rd and 4th cycles.

Table 14. Fast Program Commands, 16-bit mode⁽¹⁾

						Bus	Write op	eration	s				
Command	Length	15	st	21	nd	3r	d	41	th	5	th	61	th
	1	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data
Write to Buffer and Program	N+ 5	555	AA	2AA	55	ВА	25	ВА	N ⁽²⁾	PA ⁽³⁾	PD	WBL (4)	PD
Write to Buffer and Program Abort and Reset	3	555	AA	2AA	55	555	F0						
Write to Buffer and Program Confirm	1	BA ⁽⁵⁾	29										
Double Word Program	3	555	50	PA0	PD0	PA1	PD1						
Quadruple Word Program	5	555	56	PA0	PD0	PA1	PD1	PA2	PD2	PA3	PD3		
Unlock Bypass	3	555	AA	2AA	55	555	20						
Unlock Bypass Program	2	Х	A0	PA	PD								
Unlock Bypass Reset	2	Х	90	Х	00								

X Don't Care, PA Program Address, PD Program Data, BA Any address in the Block, BKA Bank Address, WBL Write Buffer Location. All values in the table are in hexadecimal.

- 3. Each buffer has the same A5-A22 addresses. A0-A4 are used to select a Word within the N+1 Word page.
- 4. The 6th cycle has to be issued N time. WBL scans the Word inside the page.
- 5. BA must be identical to the address loaded during the Write to buffer and Program 3rd and 4th cycles.

^{2.} The maximum number of cycles in the command sequence is 36. N+1 is the number of Words to be programmed during the Write to Buffer and Program operation.

6.3 Block Protection commands

Blocks or groups of blocks can be protected against accidental program, erase or read operations. The Protection Groups are shown in *Appendix A*, *Table 34: Block Addresses and Protection Groups*. The device block protection scheme is shown in *Figure 7: Software Protection scheme* and *Figure 6: Block Protection State diagram*. See either *Table 15*, or *Table 16*, depending on the configuration that is being used, for a summary of the Block Protection commands.

Only the commands related to the Extended Block Protection are available in both 8 bit and 16 bit memory configuration. The other block protection commands are available in 16-bit configuration only.

6.3.1 Enter Extended Block command

The M29DW128F has one extra 256-byte block (Extended Block) that can only be accessed using the Enter Extended Block command.

Three Bus Write cycles are required to issue the Extended Block command. Once the command has been issued the device enters the Extended Block mode where all Bus Read or Program operations are conducted on the Extended Block. Once the device is in the Extended Block mode, the Extended Block is addressed by using the addresses occupied by the boot blocks in the other operating modes (see *Table 34: Block Addresses and Protection Groups*).

The device remains in Extended Block mode until the Exit Extended Block command is issued or power is removed from the device. After power-up or a hardware reset, the device reverts to the Read mode where commands issued to the Boot Block Address space will address the Boot Blocks.

Note that when the device is in the Extended Block mode, the V_{PP}/\overline{WP} pin cannot be used for fast programming and the Unlock Bypass mode is not available.

The Extended Block cannot be erased, and can be treated as one-time programmable (OTP) memory. In Extended Block mode only array cell locations (Bank A) with the same addresses as the Extended Block are not accessible. In Extended Block mode dual operations are allowed and the Extended Block physically belongs to Bank A.

In Extended Block mode, Erase, Chip Erase, Erase Suspend and Erase resume commands are not allowed.

To exit from the Extended Block mode the Exit Extended Block command must be issued.

The Extended Block can be protected by setting the Extended Block Protection bit to '1'; however once protected the protection cannot be undone.

6.3.2 Exit Extended Block command

The Exit Extended Block command is used to exit from the Extended Block mode and return the device to Read mode. Four Bus Write operations are required to issue the command.

6.3.3 Set Extended Block Protection bit command

The Set Extended Block Protection bit command programs the Extended Block Protection bit to '1' thus preventing the second section of the Extended Block from being programmed.

A Read/Reset command must be issued to abort a Set Extended Block Protection bit command.

Six successive steps are required to issue the Set Extended Block Protection bit command.

- 1. The command starts with two unlock cycles.
- 2. The third Bus Write cycle sets up the Set Extended Block Protection bit command.
- The fourth Bus Write Cycle programs the Extended Block Protection bit to '1'.
- 4. The last two cycles verify the value programmed at the Extended Block Protection bit address: if bit DQ0 of Data Inputs/Outputs is set to '1', it indicates that the Extended Block Protection bit has been successfully programmed. If DQ0 is '0', the Set Extended Block Protection bit command must be issued and verified again.

6.3.4 Verify Extended Block Protection bit command

The Verify Extended Block Protection bit command reads the status of the Extended Block Protection bit on bit DQ0 of the Data Inputs/Outputs. If DQ0 is '1', the second section of the Extended Block is protected from program operations.

6.3.5 Password Program command

The Password Program Command is used to program the 64-bit Password used in Password Protection mode.

Four cycles are required to program the Password:

- The first two cycles are unlock cycles.
- 2. The third cycle issues the Password Program command.
- 3. The fourth cycle inputs the 16-bit data required to program the Password.

To program the 64-bit Password, the complete command sequence must be entered four times at four consecutive addresses selected by A1 to A0.

Read operations can be used to read the Status Register during a Password Program operation. All other operations are forbidden.

The Password can be checked by issuing a Password Verify command.

Once Password Program operation has completed, a Read/ Reset command must be issued to return the device to Read mode. The Password Protection mode can then be selected.

By default, all Password bits are set to '1'.

6.3.6 Password Verify command

The Password Verify Command is used to verify the Password used in Password Protection mode. To verify the 64-bit Password, the complete command sequence must be entered four times at four consecutive addresses selected by A1 to A0. If the Password Mode Locking bit is programmed and the user attempts to verify the Password, the device will output all F's onto the I/O data bus. The Password is output regardless of the bank address.

The user must issue a Read/reset command to return the device to Read mode.

Dual operations are not allowed during a Password Verify operation.

6.3.7 Password Protection Unlock command

The Password Protection Unlock command is used to clear the Lock-Down bit in order to unprotect all Non-Volatile Modify Protection bits when the device is in Password Protection mode. The Password Protection Unlock command must be issued along with the correct Password.

The complete command sequence must be entered for each 16 bits of the Password.

There must be a 2µs delay between successive Password Protection Unlock commands in order to prevent hackers from cracking the Password by trying all possible 64-bit combinations. If this delay is not respected, the latest command will be ignored.

6.3.8 Set Password Protection mode command

The Set Password Protection Mode command puts the device in Password Protection mode by programming the Password Protection Mode Lock bit to '1'. This command can be issued either with the Reset/Block Temporary Unprotect pin, \overline{RP} , at V_{ID} or at V_{IH} .

Six cycles are required to issue a Set Password Protection Mode command:

- The first two cycles are unlock cycles.
- 2. The third cycle issues the command.
- 3. The fourth and fifth cycles select the address (see *Table 34*).
- 4. The last cycle verifies if the operation has been successful. If DQ0 is set to '1', the device has successfully entered the Password Protection mode. If DQ0 is '0', the operation has failed and the command must be re-issued.

There must be a 100µs delay between the fourth and fifth cycles.

Once the Password Protection mode is activated the device will permanently remain in this mode.

6.3.9 Verify Password Protection mode command

The Verify Password Protection Mode command reads the status of the Password Protection Mode Lock bit. If it is '1', the device is in Password Protection mode.

6.3.10 Set Standard Protection mode command

The Set Standard Protection Mode command puts the device in Standard Protection mode by programming the Standard Protection Mode Lock bit to '1'.

Six cycles are required to issue the Standard Protection Mode command:

- The first two cycles are unlock cycles.
- 2. The third cycle issues the program command.
- 3. The fourth and fifth cycles select the address (see *Table 34*).
- 4. The last cycle verifies if the operation has been successful. If DQ0 is set to '1', the Standard Protection Mode has been successfully activated. If DQ0 is '0', the operation has failed and the command must be re-issued.

There must be a 100µs delay between the fourth and fifth cycles.

Once the Standard Protection mode is activated the device will permanently remain in this mode.

6.3.11 Verify Standard Protection mode command

The Verify Standard Protection Mode command reads the status of the Standard Protection Mode Lock bit. If it is '1', the device is in Standard Protection mode.

6.3.12 Set Non-Volatile Modify Protection bit command

A block or group of blocks can be protected from program or erase by issuing a Set Non-Volatile Modify Protection bit command along with the block address. This command sets the Non-Volatile Modify Protection bit to '1' for a given block or group of blocks.

Six cycles are required to issue the command:

- 1. The first two cycles are unlock cycles.
- 2. The third cycle issues the program command.
- 3. The fourth and fifth cycles select the address (see *Table 34*).
- 4. The last cycle verifies if the operation has been successful. If DQ0 is set to '1', the Non-Volatile Modify Protection bit has been successfully programmed. If DQ0 is '0', the operation has failed and the command must be re-issued.

There must be a 100µs delay between the fourth and fifth cycles.

The Non-Volatile Modify Protection bits are erased simultaneously by issuing a Clear Non-Volatile Modify Protection bits command except if the Lock-Down bit is set to '1'.

The Non-Volatile Modify Protection bits can be set a maximum of 100 times.

6.3.13 Verify Non-Volatile Modify Protection bit command

The status of a Non-Volatile Modify Protection bit for a given block or group of blocks can be read by issuing a Verify Non-Volatile Modify Protection Bit command along with the block address.

6.3.14 Clear Non-Volatile Modify Protection bits command

This command is used to clear all Non-Volatile Modify Protection bits. No specific block address is required. If the Lock-Down bit is set to '1', the command will fail.

Six cycles are required to issue a Clear Non-Volatile Modify Protection bits command:

- 1. The first two cycles are unlock cycles.
- 2. The third cycle issues the command.
- 3. The last three cycles verify if the operation has been successful. If DQ0 is set to '0', all Non-Volatile Modify Protection bits have been successfully cleared. If DQ0 is '1', the operation has failed and the command must be re-issued.

There must be a 12ms delay between the fourth and fifth cycles.

6.3.15 Set Lock bit command

The Set Lock bit command individually sets the Lock bit to '1' for a given block or group of blocks.

If the Non-Volatile Lock bit for the same block or group of blocks is set, the block is locked regardless of the value of the Lock bit. (see *Table 10: Block Protection status*).

6.3.16 Clear Lock bit command

The Clear Lock bit command individually clears (sets to '0') the Lock bit for a given block or group of blocks.

If the Non-Volatile Lock bit for the same block or group of blocks is set, the block or group of blocks remains locked (see *Table 10: Block Protection status*).

6.3.17 Verify Lock bit command

The status of a Lock bit for a given block can be read by issuing a Verify Lock bit command along with the block address.

6.3.18 Set Lock-Down bit command

This command is used to set the Lock-Down bit to '1' thus protecting the Non-Volatile Modify Protection bits from program and erase.

There is no Unprotect Lock-Down bit command.

6.3.19 Verify Lock-Down bit command

This command is used to read the status of the Lock-Down bit. The status is output on bit DQ1. If DQ1 is '1', all the Non-Volatile Modify Protection bits are protected from program or erase operations.

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Table 15. Block Protection Commands, 8-bit mode⁽¹⁾⁽²⁾

	_					E	Bus ope	rations	\$				
Command	ength	1:	st	2	nd	3r	ď	4	th	51	th	6	ith
	_	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data
Set Extended Block Protection bit	6	AAA	AA	555	55	AAA	60	OW	68	OW (3)	48	OW	DQ0
Verify Extended Block Protection bit	4	AAA	AA	555	55	AAA	60	OW	DQ0				
Enter Extended Block	3	AAA	AA	555	55	AAA	88						
Exit Extended Block	4	AAA	AA	555	55	AAA	90	Х	00				

- 1. OW Extended Block Protection bit Address (A7-A0='00011010'), X Don't Care. All values in the table are in hexadecimal.
- 2. Grey cells represent Read cycles. The other cells are Write cycles.
- 3. A $100\mu s$ timeout is required between cycles 4 and 5.

Table 16. Block Protection Commands, 16-bit mode (1)(2)(3)(4)

	_							Bu	s operation	ons					
Command	Length	1	st	21	nd	3	rd	41	th	5	th	6t	h	7	th
	ר	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data
Set Extended Block Protection bit ⁽⁵⁾⁽⁶⁾	6	555	AA	2AA	55	555	60	ow	68	OW	48	OW	DQ0		
Verify Extended Block Protection bit	4	555	AA	2AA	55	555	60	OW	DQ0						
Enter Extended Block	3	555	AA	2AA	55	555	88								
Exit Extended Block	4	555	AA	2AA	55	555	90	Х	00						
Password Program ⁽⁵⁾⁽⁷⁾⁽⁸⁾	4	555	AA	2AA	55	555	38	X[0-3]	PW [0-3]						
Password Verify ⁽⁸⁾⁽⁹⁾	4	555	AA	2AA	55	555	C8	PWA [0-3]	RPW [0-3]						
Password Protection Unlock ⁽⁷⁾⁽¹⁰⁾⁽¹¹⁾	7	555	AA	2AA	55	555	28	PWA[0]	RPW[0]	PWA [1]	RPW [1]	PWA [2]	RPW [2]	PWA [3]	RPW [3]
Set Password Protection mode ⁽⁵⁾⁽⁶⁾	6	555	AA	2AA	55	555	60	PL	68	PL	48	PL	DQ0		
Verify Password Protection mode	4	555	AA	2AA	55	555	60	PL	DQ0						
Set Non- Volatile Modify Protection bit ⁽⁵⁾ (6)	6	555	AA	2AA	55	555	60	(BA)/ NVMP	68	(BA)/ NVMP	48	(BA)/ NVMP	DQ0		

Table 16. Block Protection Commands, 16-bit mode (continued)(1)(2)(3)(4)

								Bus	s operation	ons					
Command	Length	1	st	21	nd	3	rd		th	1	th	6t	th	7	th
	_	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data	Add	Data
Verify Non- Volatile Modify Protection bit	4	555	AA	2AA	55	555	60	(BA) [/] NVMP	48	(BA)/ NVMP	DQ0				
Clear Non- Volatile Modify Protection bits ⁽¹²⁾ (13)(14)	6	555	AA	2AA	55	555	60	NVMP	60	(BA)/ NVMP	40	(BA)/ NVMP	DQ0		
Set Lock-Down bit	3	555	AA	2AA	55	555	78								
Verify Lock- Down bit ⁽¹⁵⁾	4	555	AA	2AA	55	555	58	ВА	DQ1						
Set Lock bit ⁽⁷⁾	4	555	AA	2AA	55	555	48	ВА	X1h						
Clear Lock bit ⁽⁷⁾	4	555	AA	2AA	55	555	48	ВА	X0h						
Verify Lock bit	4	555	AA	2AA	55	555	58	ВА	DQ0						
Set Standard Protection mode ⁽⁵⁾⁽⁶⁾	6	555	AA	2AA	55	555	60	SL	68	SL	48	SL	DQ0		
Verify Standard Protection mode ⁽⁵⁾	4	555	AA	2AA	55	555	60	SL	DQ0						

- 1. Grey cells represent Read cycles. The other cells are Write cycles.
- SA Protection Group Address, BA Any address in the Block, BKA Bank Address, SL Standard Protection Mode Lock bit Address, PL Password Protection Mode Lock bit Address, PW Password Data, PWA Password Address, RPW Password Data Being Verified, NVMP Non-Volatile Modify Protection bit Address, OW Extended Block Protection bit Address, X Don't Care. All values in the table are in hexadecimal.
- 3. Addresses are described in Table 34.
- 4. During Unlock and Command cycles, if the lower address bits are 555h or 2AAh then the address bits higher than A11 (except where BA is required) and data bits higher than DQ7 are Don't Care.
- 5. A Reset Command must be issued to return to the Read mode.
- 6. The 4th Bus Write cycle programs a protection bit (Extended Block Protection bit, Password Protection Mode Lock bit, Standard Protection Mode Lock bit, and a block NVMP bit). The 5th and 6th cycles verify that the bit has been successively programmed when DQ0=1. If DQ0=0 in the 6th cycle, the program command must be issued again and verified again. A 100µs delay is required between the 4th and the 5th cycle.
- 7. Data is latched on the rising edge of \overline{W} .
- 8. The entire command sequence must be entered for each portion of the password.
- 9. The command sequence returns FFh if the Password Protection Mode locking bit is set.
- 10. The password is written over four consecutive cycles, at addresses [0-3]
- 11. A 2µs timeout is required between any two portions of the password.
- 12. A 10ms delay is required between the 4th and the 5th cycle.
- 13. A 12ms timeout is required between cycles 4 and 5.
- 14. Cycle 4 erases all Non-Volatile Modify Protection bits. Cycles 5 and 6 verify that the bits have been successfully cleared when DQ0=0. If DQ0=1 in the 6th cycle, the erase command must be issued again and verified again. Before issuing the erase command, all Non-Volatile Modify Protection bits should be programmed to prevent over erasure.
- 15. DQ1=1 if the Non-Volatile Modify Protection bit is locked, DQ1 = 0 if it is unlocked.

Table 17. Protection Command Addresses

Bit	Condition	Address Inputs A7-A0	Other Address Inputs
Password Protection Mode Lock bit Address	RP at V _{IH}	00001010	Х
(PL)	RP at V _{ID}	10001010	Х
Standard Protection Mode Lock bit Address (SL)		00010010	Х
Non-Volatile Modify Protection bit Address (NVM	IP)	00000010	Block Protection Group Address
Extended Block Protection bit Address (OW)		00011010	Х

Table 18. Program, Erase Times and Program, Erase Endurance Cycles

	Parameter		Min	Typ ⁽¹⁾⁽²⁾	Max ⁽²⁾	Unit
Chip Erase				80	400 ⁽³⁾	S
Block Erase (64 kl	bytes)			0.8	6 ⁽⁴⁾	S
Erase Suspend La	atency Time				50 ⁽⁴⁾	μs
	Single or Multiple byte Program (1, 2, 4 or 8 bytes at-a-time)	m		10	200 ⁽³⁾	μs
Byte Program	Write to Buffer and Program	$V_{PP}/\overline{WP} = V_{PPH}$		90	700 ⁽³⁾	μs
	(64 bytes at-a-time)	V _{PP} /WP=V _{IH}		280	1400 ⁽³⁾	μs
	Single or Multiple Word Progra (1, 2 or 4 Words at-a-time)	am		10	200 ⁽³⁾	μs
Word Program	Write to Buffer and Program	V _{PP} /WP=V _{PPH}		90	700 ⁽³⁾	μs
	(32 Words at-a-time)	V _{PP} /WP=V _{IH}		280	1400 ⁽³⁾	μs
Chip Program (byt	te by byte)			80	400 ⁽³⁾	S
Chip Program (Wo	ord by Word)			40	200 ⁽³⁾	S
Chip Program (Qu	adruple byte or Double Word)			20	100 ⁽³⁾	S
Chip Program (Oc	tuple byte or Quadruple Word)			10	50 ⁽³⁾	S
Program Suspend	Latency Time			5	15	μs
Program/Erase Cy	/cles (per Block)		100,000			cycles
Data Retention			20			years

^{1.} Typical values measured at room temperature and nominal voltages.

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^{2.} Sampled, but not 100% tested.

^{3.} Maximum value measured at worst case conditions for both temperature and V_{CC} after 100,00 program/erase cycles.

^{4.} Maximum value measured at worst case conditions for both temperature and $V_{\mbox{\footnotesize{CC}}}$.

M29DW128F Status Register

7 Status Register

The M29DW128F has one Status Register. The Status Register provides information on the current or previous Program or Erase operations executed in each bank. The various bits convey information and errors on the operation. Bus Read operations from any address within the Bank, always read the Status Register during Program and Erase operations. It is also read during Erase Suspend when an address within a block being erased is accessed.

The bits in the Status Register are summarized in Table 19: Status Register bits.

7.1 Data Polling bit (DQ7)

The Data Polling bit can be used to identify whether the Program/Erase Controller has successfully completed its operation or if it has responded to an Erase Suspend. The Data Polling bit is output on DQ7 when the Status Register is read.

During Program operations the Data Polling bit outputs the complement of the bit being programmed to DQ7. After successful completion of the Program operation the memory returns to Read mode and Bus Read operations from the address just programmed output DQ7, not its complement.

During Erase operations the Data Polling bit outputs '0', the complement of the erased state of DQ7. After successful completion of the Erase operation the memory returns to Read mode.

In Erase Suspend mode the Data Polling bit will output a '1' during a Bus Read operation within a block being erased. The Data Polling bit will change from a '0' to a '1' when the Program/Erase Controller has suspended the Erase operation.

Figure 8: Data Polling flowchart, gives an example of how to use the Data Polling bit. A Valid Address is the address being programmed or an address within the block being erased.

7.2 Toggle bit (DQ6)

The Toggle bit can be used to identify whether the Program/Erase Controller has successfully completed its operation or if it has responded to an Erase Suspend. The Toggle bit is output on DQ6 when the Status Register is read.

During a Program/Erase operation the Toggle bit changes from '0' to '1' to '0', etc., with successive Bus Read operations at any address. After successful completion of the operation the memory returns to Read mode.

During Erase Suspend mode the Toggle bit will output when addressing a cell within a block being erased. The Toggle bit will stop toggling when the Program/Erase Controller has suspended the Erase operation.

Figure 9: Toggle flowchart, gives an example of how to use the Data Toggle bit. Figure 16 and Figure 17 describe Toggle bit timing waveform.

Status Register M29DW128F

7.3 Error bit (DQ5)

The Error bit can be used to identify errors detected by the Program/Erase Controller. The Error bit is set to '1' when a Program, Block Erase or Chip Erase operation fails to write the correct data to the memory. If the Error bit is set a Read/Reset command must be issued before other commands are issued. The Error bit is output on DQ5 when the Status Register is read.

Note that the Program command cannot change a bit set to '0' back to '1' and attempting to do so will set DQ5 to '1'. A Bus Read operation to that address will show the bit is still '0'. One of the Erase commands must be used to set all the bits in a block or in the whole memory from '0' to '1'.

7.4 Erase Timer bit (DQ3)

The Erase Timer bit can be used to identify the start of Program/Erase Controller operation during a Block Erase command. Once the Program/Erase Controller starts erasing the Erase Timer bit is set to '1'. Before the Program/Erase Controller starts the Erase Timer bit is set to '0' and additional blocks to be erased may be written to the Command Interface. The Erase Timer bit is output on DQ3 when the Status Register is read.

7.5 Alternative Toggle bit (DQ2)

The Alternative Toggle bit can be used to monitor the Program/Erase controller during Erase operations. The Alternative Toggle bit is output on DQ2 when the Status Register is read.

During Chip Erase and Block Erase operations the Toggle bit changes from '0' to '1' to '0', etc., with successive Bus Read operations from addresses within the blocks being erased. A protected block is treated the same as a block not being erased. Once the operation completes the memory returns to Read mode.

During Erase Suspend the Alternative Toggle bit changes from '0' to '1' to '0', etc. with successive Bus Read operations from addresses within the blocks being erased. Bus Read operations to addresses within blocks not being erased will output the memory array data as if in Read mode.

After an Erase operation that causes the Error bit to be set, the Alternative Toggle bit can be used to identify which block or blocks have caused the error. The Alternative Toggle bit changes from '0' to '1' to '0', etc. with successive Bus Read Operations from addresses within blocks that have not erased correctly. The Alternative Toggle bit does not change if the addressed block has erased correctly.

Figure 16 and Figure 17 describe Alternative Toggle bit timing waveform.

7.6 Write to Buffer and Program Abort bit (DQ1)

The Write to Buffer and Program Abort bit, DQ1, is set to '1' when a Write to Buffer and Program operation aborts. The Write to Buffer and Program Abort and Reset command must be issued to return the device to Read mode (see Write to Buffer and Program in COMMANDS section).

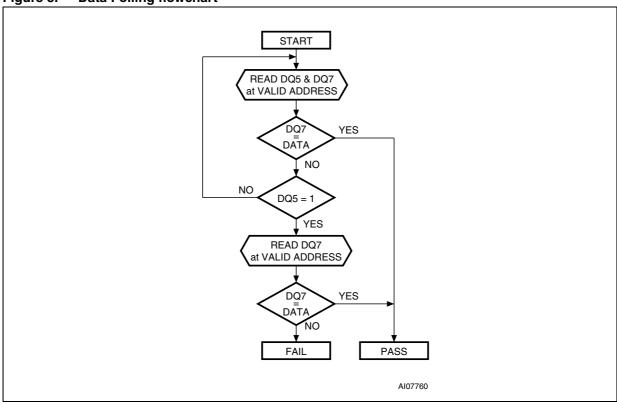
M29DW128F Status Register

Table 19. Status Register bits⁽¹⁾⁽²⁾

Operation	Address	DQ7	DQ6	DQ5	DQ3	DQ2	DQ1	R₩
Program	Bank Address	DQ7	Toggle	0	_	_	0	0
Program During Erase Suspend	Bank Address	DQ7	Toggle	0	_	_	_	0
Write to Buffer and Program Abort	Bank Address	DQ7	Toggle	0	-	_	1	0
Program Error	Bank Address	DQ7	Toggle	1	_	-	_	Hi-Z
Chip Erase	Any Address	0	Toggle	0	1	Toggle	_	0
Block Erase before	Erasing Block	0	Toggle	0	0	Toggle	_	0
timeout	Non-Erasing Block	0	Toggle	0	0	No Toggle	_	0
Block Erase	Erasing Block	0	Toggle	0	1	Toggle	_	0
DIOCK ETase	Non-Erasing Block	0	Toggle	0	1	No Toggle	_	0
Erase Suspend	Erasing Block	1	No Toggle	0	_	Toggle	_	Hi-Z
Erase Suspend	Non-Erasing Block		Data	read as i	normal		_	Hi-Z
Erase Error	Good Block Address	0	Toggle	1	1	No Toggle	_	Hi-Z
LIASE EIIUI	Faulty Block Address	0	Toggle	1	1	Toggle	_	Hi-Z

^{1.} Unspecified data bits should be ignored.

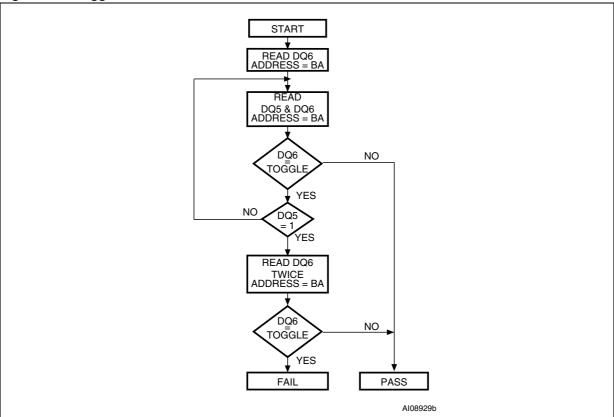
Figure 8. Data Polling flowchart



^{2.} Figure 16 and Figure 17 describe Toggle and Alternative Toggle bits timing waveforms.

Status Register M29DW128F

Figure 9. Toggle flowchart



1. BA = Address of Bank being Programmed or Erased.

Dual Operations and Multiple Bank architecture 8

The Multiple Bank Architecture of the M29DW128F gives greater flexibility for software developers to split the code and data spaces within the memory array. The Dual Operations feature simplifies the software management of the device by allowing code to be executed from one bank while another bank is being programmed or erased.

The Dual Operations feature means that while programming or erasing in one bank, read operations are possible in another bank with zero latency.

Only one bank at a time is allowed to be in program or erase mode. However, certain commands can cross bank boundaries, which means that during an operation only the banks that are not concerned with the cross bank operation are available for dual operations. For example, if a Block Erase command is issued to erase blocks in both Bank A and Bank B, then only Banks C or D are available for read operations while the erase is being executed.

If a read operation is required in a bank, which is programming or erasing, the program or erase operation can be suspended.

Also if the suspended operation was erase then a program command can be issued to another block, so the device can have one block in Erase Suspend mode, one programming and other banks in read mode.

By using a combination of these features, read operations are possible at any moment.

Table 20 and Table 21 show the dual operations possible in other banks and in the same bank. Note that only the commonly used commands are represented in these tables.

Dual Operations allowed in other Banks⁽¹⁾ Table 20.

	Commands allowed in another bank											
Status of Bank	Read/ Reset	Read Status Register ⁽²⁾	Read CFI Query	Auto Select	Program	Erase	Program/ Erase Suspend	Program/ Erase Resume				
Idle	Yes	Yes ⁽³⁾	Yes	Yes	Yes	Yes	Yes ⁽³⁾	Yes ⁽⁴⁾				
Programming	Yes	No	No	No	-	_	No	No				
Erasing	Yes	No	No	No	-	_	No	No				
Program Suspended	Yes	No	Yes	Yes	No	No	-	Yes ⁽⁵⁾				
Erase Suspended	Yes	No	Yes	Yes	Yes	No	-	Yes ⁽⁶⁾				

- If several banks are involved in a program or erase operation, then only the banks that are not concerned with the operation are available for dual operations.
- 2. Read Status Register is not a command. The Status Register can be read during a block program or erase operation.
- 3. Only after a program or erase operation in that bank.
- 4. Only after a Program or Erase Suspend command in that bank.
- 5. Only a Program Resume is allowed if the bank was previously in Program Suspend mode.
- 6. Only an Erase Resume is allowed if the bank was previously in Erase Suspend mode.

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Table 21. Dual Operations allowed in same Bank

			Comn	nands allo	wed in sam	e Bank		
Status of Bank	Read/ Reset	Read Status Register	Read CFI Query	Auto Select	Program	Erase	Program/ Erase Suspend	Program/ Erase Resume
Idle	Yes	Yes	Yes	Yes	Yes	Yes	Yes ⁽²⁾	Yes ⁽³⁾
Programming	No	Yes	No	No	_	_	Yes ⁽⁴⁾	_
Erasing	No	Yes	No	No	_	No	Yes ⁽⁵⁾	_
Program Suspended	Yes ⁽⁶⁾	No	Yes	Yes	No	_	_	Yes
Erase Suspended	Yes ⁽⁶⁾	Yes ⁽⁷⁾	Yes	Yes	Yes ⁽⁶⁾	No	_	Yes

Read Status Register is not a command. The Status Register can be read by addressing the block being programmed or erased.

- 2. Only after a program or erase operation in that bank.
- 3. Only after a Program or Erase Suspend command in that bank.
- 4. Only a Program Suspend.
- 5. Only an Erase suspend.
- 6. Not allowed in the Block or Word that is being erased or programmed.
- 7. The Status Register can be read by addressing the block being erase suspended.

M29DW128F Maximum rating

9 Maximum rating

Stressing the device above the rating listed in the Absolute Maximum Ratings table may cause permanent damage to the device. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Refer also to the Numonyx SURE Program and other relevant quality documents.

Table 22. Absolute maximum ratings

Symbol	Parameter	Min	Max	Unit
T _{BIAS}	Temperature Under Bias	- 50	125	°C
T _{STG}	Storage Temperature	-65	150	°C
V _{IO}	Input or Output voltage ⁽¹⁾⁽²⁾	-0.6	V _{CC} +0.6	V
V _{CC}	Supply voltage	-0.6	4	V
V _{ID}	Identification voltage	-0.6	13.5	V
V _{PP} ⁽³⁾	Program voltage	-0.6	13.5	V

^{1.} Minimum voltage may undershoot to –2V during transition and for less than 20ns during transitions.

^{2.} Maximum voltage may overshoot to V_{CC} +2V during transition and for less than 20ns during transitions.

^{3.} V_{PP} must not remain at 12V for more than a total of 80hrs.

10 DC and AC parameters

This section summarizes the operating measurement conditions, and the DC and AC characteristics of the device. The parameters in the DC and AC characteristics Tables that follow, are derived from tests performed under the Measurement Conditions summarized in *Table 23: Operating and AC measurement conditions*. Designers should check that the operating conditions in their circuit match the operating conditions when relying on the quoted parameters.

Table 23. Operating and AC measurement conditions

		M29D\	W128F		
Parameter	6	60	7	Unit	
	Min	Max	Min	Max	
V _{CC} supply voltage	2.7	3.6	2.7	3.6	V
Ambient Operating Temperature	-40	85	-40	85	°C
Load capacitance (C _L)	3	30	3	0	pF
Input Rise and Fall Times		10		10	ns
Input pulse voltages	0 to	V _{CC}	0 to	V _{CC}	V
Input and Output Timing Ref. voltages	V _C	_C /2	V _C	_C /2	V

Figure 10. AC measurement I/O waveform

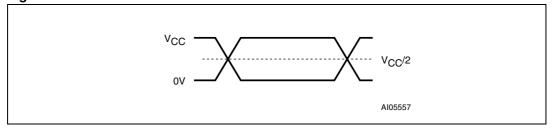
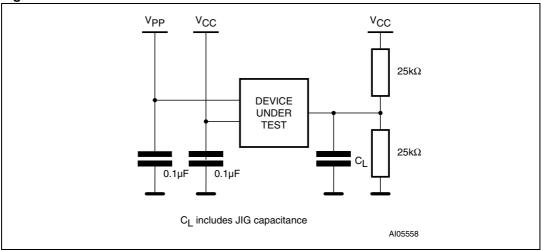


Figure 11. AC measurement Load Circuit



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Table 24. Device capacitance

Symbol	Parameter Test condition		Min	Max ⁽¹⁾	Unit
C _{IN}	Input capacitance	$V_{IN} = 0V$		6	pF
C _{OUT}	Output capacitance	V _{OUT} = 0V		12	pF

^{1.} Sampled only, not 100% tested.

Table 25. DC Characteristics

Symbol	Parameter	Test condition		Min	Max	Unit
I _{LI}	Input Leakage Current	0V ≤V _{IN}	≤V _{CC}		±1	μA
I _{LO}	Output Leakage Current	0V ≤V _{OU}	_T ≤V _{CC}		±1	μA
I _{CC1} ⁽¹⁾	Supply Current (Read)	E = V _{IL} , G f = 6N	***		10	mA
I _{CC2}	Supply Current (Standby)	$\overline{E} = V_{CC} \pm 0.2V,$ $\overline{RP} = V_{CC} \pm 0.2V$			100	μΑ
I _{CC3} ⁽¹⁾⁽²⁾	Supply Current	$V_{PP} \overline{WP} = V_{IL} \text{ or } V_{IH}$			20	mA
ICC3	(Program/Erase)	Controller active	V _{PP} /WP = V _{PPH}		20	mA
V _{IL}	Input Low voltage			-0.5	0.8	٧
V _{IH}	Input High voltage			0.7V _{CC}	V _{CC} +0.3	٧
V _{PPH}	Voltage for V _{PP} /WP Program Acceleration	V _{CC} = 2.7	V ±10%	11.5	12.5	V
I _{PP}	Current for V _{PP} /WP Program Acceleration	V _{CC} =2.7	V ±10%		15	mA
V _{OL}	Output Low voltage	I _{OL} = 1	.8mA		0.45	٧
V _{OH}	Output High voltage	I _{OH} = -100μA		V _{CC} -0.4		٧
V _{ID}	Identification voltage			11.5	12.5	٧
V _{LKO}	Program/Erase Lockout supply voltage			1.8	2.3	V

^{1.} In Dual operations the Supply Current will be the sum of I_{CC1} (read) and I_{CC3} (program/erase).

^{2.} Sampled only, not 100% tested.

Figure 12. Random Read AC waveforms

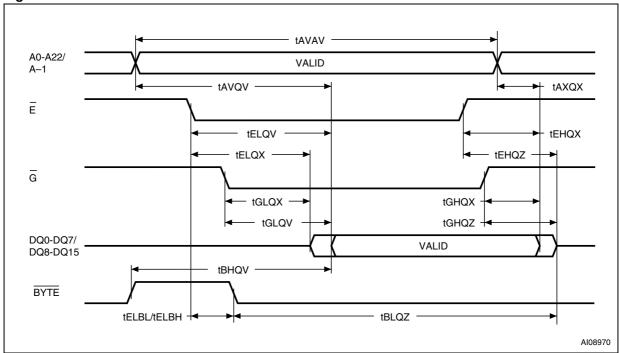


Figure 13. Page Read AC waveforms

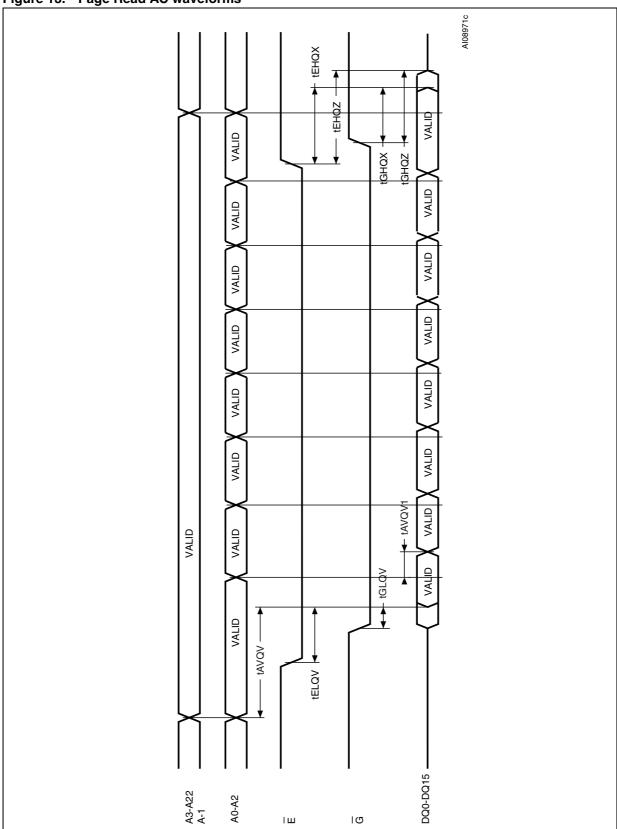


Table 26. Read AC characteristics

Compleal	A 1±	Davamatav	Tool cone	Test condition		M29DW128F		
Symbol	Alt	Parameter	lest cond	aition	60	70	Unit	
t _{AVAV}	t _{RC}	Address Valid to Next Address Valid	$\overline{E} = V_{IL},$ $\overline{G} = V_{IL}$	Min	60	70	ns	
t _{AVQV}	t _{ACC}	Address Valid to Output Valid	$\overline{E} = V_{IL},$ $\overline{G} = V_{IL}$	Max	60	70	ns	
t _{AVQV1}	t _{PAGE}	Address Valid to Output Valid (Page)			25	30	ns	
t _{ELQX} ⁽¹⁾	t_{LZ}	Chip Enable Low to Output Transition	$\overline{G} = V_{IL}$	Min	0	0	ns	
t _{ELQV}	t _{CE}	Chip Enable Low to Output Valid	$\overline{G} = V_{IL}$	Max	60	70	ns	
t _{GLQX} ⁽¹⁾	t _{OLZ}	Output Enable Low to Output Transition	E = V _{IL}	Min	0	0	ns	
t _{GLQV}	t _{OE}	Output Enable Low to Output Valid	$\overline{E} = V_{IL}$	Max	20	25	ns	
t _{EHQZ} ⁽¹⁾	t _{HZ}	Chip Enable High to Output Hi-Z	$\overline{G} = V_{IL}$	Max	25	25	ns	
t _{GHQZ} ⁽¹⁾	t _{DF}	Output Enable High to Output Hi-Z	$\overline{E} = V_{IL}$	Max	25	25	ns	
t _{EHQX} t _{GHQX} t _{AXQX}	t _{OH}	Chip Enable, Output Enable or Address Transition to Output Transition		Min	0	0	ns	
t _{ELBL}	t _{ELFL}	Chip Enable to BYTE Low or High ⁽²⁾		Max	5	5	ns	
t _{BLQZ}	t _{FLQZ}	BYTE Low to Output Hi-Z ⁽²⁾		Max	25	25	ns	
t _{BHQV}	t _{FHQV}	BYTE High to Output Valid ⁽²⁾		Max	30	30	ns	

^{1.} Sampled only, not 100% tested.

^{2.} TSOP56 package only.

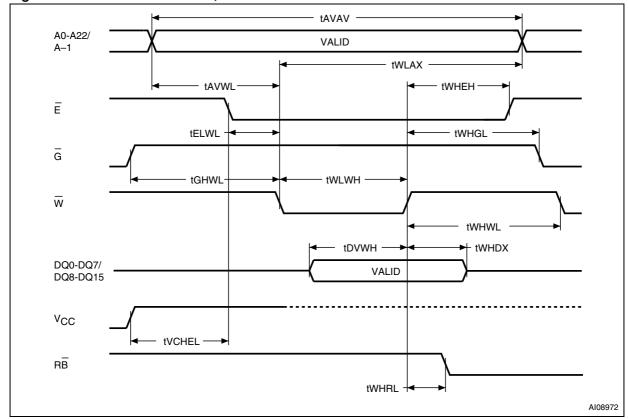


Figure 14. Write AC waveforms, Write Enable Controlled

Table 27. Write AC characteristics, Write Enable Controlled

Crossbal	Λ Ι+	Dovometov		M29D\	W128F	Heit	
Symbol	Alt	Parameter		60	70	Unit	
t _{AVAV}	t _{WC}	Address Valid to Next Address Valid	Min	60	70	ns	
t _{ELWL}	t _{CS}	Chip Enable Low to Write Enable Low	Min	0	0	ns	
t _{WLWH}	t _{WP}	Write Enable Low to Write Enable High	Min	45	45	ns	
t _{DVWH}	t _{DS}	Input Valid to Write Enable High	Min	45	45	ns	
t _{WHDX}	t _{DH}	Write Enable High to Input Transition		0	0	ns	
t _{WHEH}	t _{CH}	Write Enable High to Chip Enable High	Min	0	0	ns	
t _{WHWL}	t _{WPH}	Write Enable High to Write Enable Low	Min	30	30	ns	
t _{AVWL}	t _{AS}	Address Valid to Write Enable Low	Min	0	0	ns	
t _{WLAX}	t _{AH}	Write Enable Low to Address Transition	Min	45	45	ns	
t _{GHWL}		Output Enable High to Write Enable Low	Min	0	0	ns	
t _{WHGL}	t _{OEH}	Write Enable High to Output Enable Low Min		0	0	ns	
t _{WHRL} (1)	t _{BUSY}	Program/Erase Valid to RB Low	Max	30	30	ns	
t _{VCHEL}	t _{VCS}	V _{CC} High to Chip Enable Low	Min	50	50	μs	

^{1.} Sampled only, not 100% tested.

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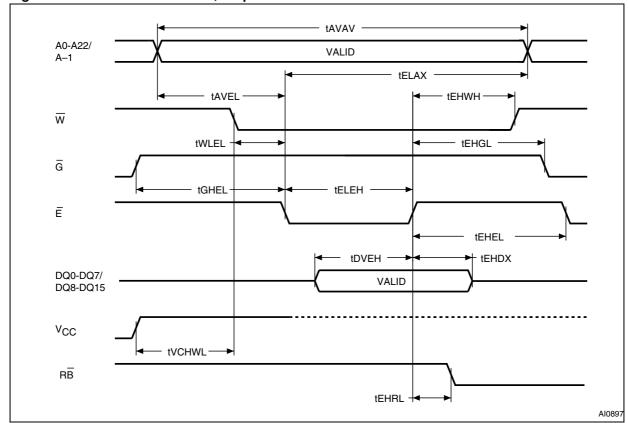


Figure 15. Write AC waveforms, Chip Enable Controlled

Table 28. Write AC characteristics, Chip Enable Controlled

Table 201 Witte 710 characteriotics, only Enable Controlled							
Complete	A 14	Bouwandou	M29DW128F		11		
Symbol	Alt	Parameter	60	70	Unit		
t _{AVAV}	t _{WC}	Address Valid to Next Address Valid	Min	60	70	ns	
t _{WLEL}	t _{WS}	Write Enable Low to Chip Enable Low	Min	0	0	ns	
t _{ELEH}	t _{CP}	Chip Enable Low to Chip Enable High	Min	45	45	ns	
t _{DVEH}	t _{DS}	Input Valid to Chip Enable High	Min	45	45	ns	
t _{EHDX}	t _{DH}	Chip Enable High to Input Transition	Min	0	0	ns	
t _{EHWH}	t _{WH}	Chip Enable High to Write Enable High	Min	0	0	ns	
t _{EHEL}	t _{CPH}	Chip Enable High to Chip Enable Low	Min	30	30	ns	
t _{AVEL}	t _{AS}	Address Valid to Chip Enable Low	Min	0	0	ns	
t _{ELAX}	t _{AH}	Chip Enable Low to Address Transition	Min	45	45	ns	
t _{GHEL}		Output Enable High Chip Enable Low	Min	0	0	ns	
t _{EHGL}	t _{OEH}	Chip Enable High to Output Enable Low Min		0	0	ns	
t _{EHRL} (1)	t _{BUSY}	Program/Erase Valid to RB Low	Max	30	30	ns	
t _{VCHWL}	t _{VCS}	V _{CC} High to Write Enable Low Min		50	50	μs	

^{1.} Sampled only, not 100% tested.

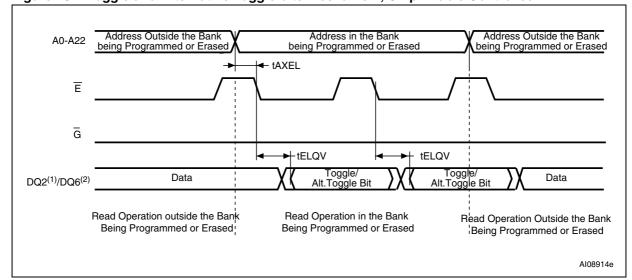
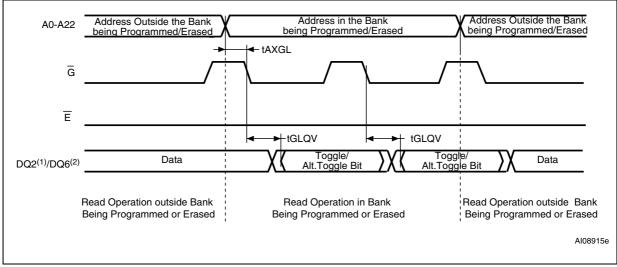


Figure 16. Toggle and Alternative Toggle bits mechanism, Chip Enable Controlled

- 1. The Toggle bit is output on DQ6.
- 2. The Alternative Toggle bit is output on DQ2.
- 3. Refer to Table 26: Read AC characteristics for the value of t_{ELQV}.

Figure 17. Toggle and Alternative Toggle bits mechanism, Output Enable Controlled



- 1. The Toggle bit is output on DQ6.
- 2. The Alternative Toggle bit is output on DQ2.
- 3. Refer to Table 26: Read AC characteristics for the value of t_{GLQV}.

Table 29. Toggle and Alternative Toggle bits AC characteristics

Symbol	Alt	Parameter		M29D\	<i>N</i> 128F	Unit
Symbol	Ait	raiametei	60	70	Oille	
t _{AXEL}		Address Transition to Chip Enable Low	ddress Transition to Chip Enable Low Min		10	ns
t _{AXGL}		Address Transition to Output Enable Low	10	10	ns	

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Figure 18. Reset/Block Temporary Unprotect AC waveforms (No Program/Erase ongoing)

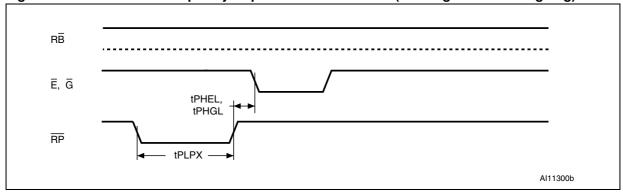


Figure 19. Reset/Block Temporary Unprotect During Program/Erase Operation AC waveforms

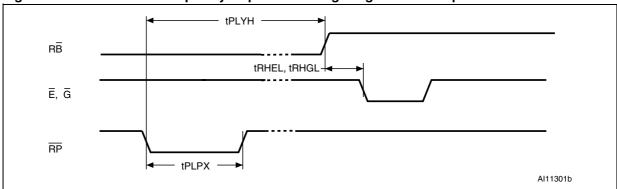


Figure 20. Accelerated Program Timing waveforms

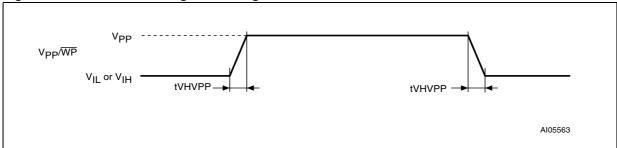


Table 30. Reset/Block Temporary Unprotect AC characteristics

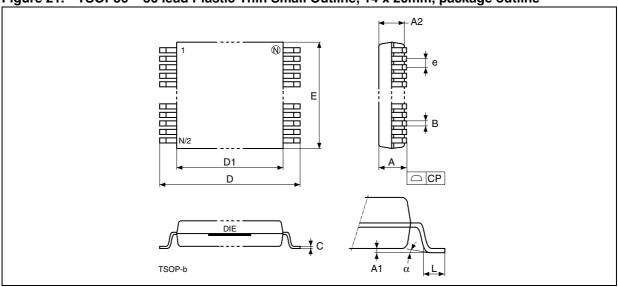
Cymphol	ΛI÷	Alt Parameter				Unit
Symbol	Symbol Ait Parameter				70	Unit
t _{PLYH} ⁽¹⁾	t _{READY}	RP Low to Read mode, during Program or Erase	Max	20		μs
t _{PLPX}	t _{RP}	RP Pulse Width	Min	500		ns
t _{PHEL} t _{PHGL} (1)	t _{RH}	RP High to Write Enable Low, Chip Enable Low, Output Enable Low	Min	50		ns
	t _{RPD}	RP Low to Standby Mode. Min		2	0	ns
t _{RHEL}	t _{RB}	RB High to Write Enable Low, Chip Enable Low, Output Enable Low		C)	ns

^{1.} Sampled only, not 100% tested.

Package mechanical M29DW128F

11 Package mechanical

Figure 21. TSOP56 – 56 lead Plastic Thin Small Outline, 14 x 20mm, package outline



^{1.} Drawing is not to scale.

Table 31. TSOP56 – 56 lead Plastic Thin Small Outline, 14 x 20mm, package mechanical data

Complete		millimeters			inches			
Symbol	Тур	Min	Max	Тур	Min	Max		
Α			1.200			0.0472		
A1	0.100	0.050	0.150	0.0039	0.0020	0.0059		
A2	1.000	0.950	1.050	0.0394	0.0374	0.0413		
В	0.220	0.170	0.270	0.0087	0.0067	0.0106		
С		0.100	0.210		0.0039	0.0083		
СР			0.100			0.0039		
D	20.000	19.800	20.200	0.7874	0.7795	0.7953		
D1	18.400	18.300	18.500	0.7244	0.7205	0.7283		
е	0.500	-	-	0.0197	-	_		
E	14.000	13.900	14.100	0.5512	0.5472	0.5551		
L	0.600	0.500	0.700	0.0236	0.0197	0.0276		
α	3°	0	5°	3°	0	5°		
N	56			56				

M29DW128F Package mechanical

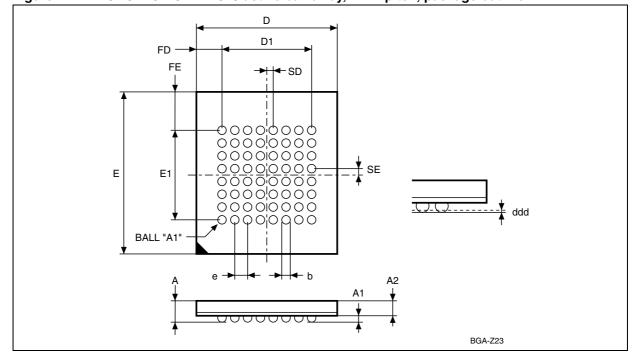


Figure 22. TBGA64 10x13mm - 8x8 active ball array, 1mm pitch, package outline

1. Drawing is not to scale.

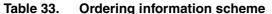
Table 32. TBGA64 10x13mm - 8x8 active ball array, 1mm pitch, package mechanical data

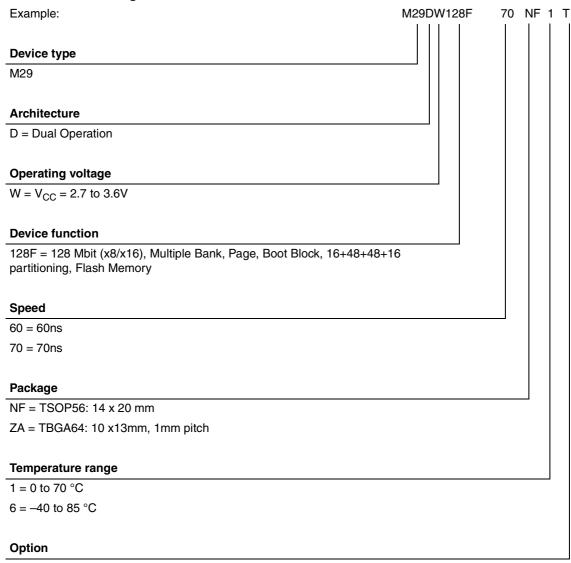
Cumbal	millimeters			inches			
Symbol	Тур	Min	Max	Тур	Min	Max	
Α			1.200			0.0472	
A1	0.300	0.200	0.350	0.0118	0.0079	0.0138	
A2	0.800			0.0315			
b		0.350	0.500		0.0138	0.0197	
D	10.000	9.900	10.100	0.3937	0.3898	0.3976	
D1	7.000	-	_	0.2756	-	_	
ddd			0.100			0.0039	
е	1.000	-	_	0.0394	-	_	
Е	13.000	12.900	13.100	0.5118	0.5079	0.5157	
E1	7.000	-	_	0.2756	-	_	
FD	1.500	-	_	0.0591	-	_	
FE	3.000	-	-	0.1181	-	_	
SD	0.500	-	-	0.0197	-	_	
SE	0.500	_	_	0.0197	-	_	

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Part numbering M29DW128F

12 Part numbering





Blank = Standard Packing

T = Tape & Reel Packing

E = ECOPACK Package, Standard Packing

F = ECOPACK Package, Tape & Reel 24mm Packing

Note: This product is also available with the Extended Block factory locked. For further details and ordering information contact your nearest Numonyx sales office.

Devices are shipped from the factory with the memory content bits erased to '1'.

For a list of available options (Speed, Package, etc.) or for further information on any aspect of this device, please contact your nearest Numonyx Sales Office.

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Block addresses and Read/Modify Protection Groups Appendix A

Table 34. **Block Addresses and Protection Groups**

Bank	Block	Size (kbytes/KWords)	Protection Block Group	(x8)	(x16)
	0	8/4	Protection Group	000000h-001FFFh ⁽¹⁾	000000h-000FFFh ⁽¹⁾
	1	8/4	Protection Group	002000h-003FFFh ⁽¹⁾	001000h-001FFFh ⁽¹⁾
	2	8/4	Protection Group	004000h-005FFFh ⁽¹⁾	002000h-002FFFh ⁽¹⁾
	3	8/4	Protection Group	006000h-007FFFh ⁽¹⁾	003000h-003FFFh ⁽¹⁾
	4	8/4	Protection Group	008000h-009FFFh ⁽¹⁾	004000h-004FFFh ⁽¹⁾
	5	8/4	Protection Group	00A000h-00BFFFh ⁽¹⁾	005000h-005FFFh ⁽¹⁾
	6	8/4	Protection Group	00C000h-00DFFFh ⁽¹⁾	006000h-006FFFh ⁽¹⁾
	7	8/4	Protection Group	00E000h-00FFFFh ⁽¹⁾	007000h-007FFFh ⁽¹⁾
	8	64/32		010000h-01FFFFh	008000h-00FFFFh
	9	64/32	Protection Group	020000h-02FFFFh	010000h-017FFFh
	10	64/32		030000h-03FFFFh	018000h-01FFFFh
	11	64/32		040000h-04FFFFh	020000h-027FFFh
∢	12	64/32	Protection Group	050000h-05FFFFh	028000h-02FFFFh
Bank A	13	64/32	1 Totection Group	060000h-06FFFFh	030000h-037FFFh
В	14	64/32		070000h-07FFFFh	038000h-03FFFFh
	15	64/32		080000h-08FFFFh	040000h-047FFFh
	16	64/32	Protection Group	090000h-09FFFFh	048000h-04FFFFh
	17	64/32	Frotection Group	0A0000h-0AFFFFh	050000h-057FFFh
	18	64/32		0B0000h-0BFFFFh	058000h-05FFFFh
	19	64/32		0C0000h-0CFFFFh	060000h-067FFFh
	20	64/32	Protection Group	0D0000h-0DFFFFh	068000h-06FFFFh
	21	64/32	Frotection Group	0E0000h-0EFFFFh	070000h-077FFFh
	22	64/32		0F0000h-0FFFFh	078000h-07FFFFh
	23	64/32		100000h-10FFFFh	080000h-087FFFh
	24	64/32	Protection Group	110000h-11FFFFh	088000h-08FFFFh
	25	64/32	Protection Group	120000h-12FFFFh	090000h-097FFFh
	26	64/32		130000h-13FFFFh	098000h-09FFFFh

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Table 34. Block Addresses and Protection Groups (continued)

Bank	Block	Size (kbytes/KWords)	Protection Block Group	(x8)	(x16)
	27	64/32		140000h-14FFFFh	0A0000h-0A7FFFh
	28	64/32	Dratastian Croup	150000h-15FFFFh	0A8000h-0AFFFFh
	29	64/32	Protection Group	160000h-16FFFFh	0B0000h-0B7FFFh
	30	64/32		170000h-17FFFFh	0B8000h-0BFFFFh
	31	64/32		180000h-18FFFFh	0C0000h-0C7FFFh
A A	32	64/32	Durata ati an Oussur	190000h-19FFFFh	0C8000h-0CFFFFh
Bank A	33	64/32	Protection Group	1A0000h-1AFFFFh	0D0000h-0D7FFFh
	34	64/32	Protection Group	1B0000h-1BFFFFh	0D8000h-0DFFFFh
	35	64/32		1C0000h-1CFFFFh	0E0000h-0E7FFh
	36	64/32		1D0000h-1DFFFFh	0E8000h-0EFFFFh
	37	64/32	Protection Group	1E0000h-1EFFFFh	0F0000h-0F7FFh
	38	64/32		1F0000h-1FFFFFh	0F8000h-0FFFFh
	39	64/32		200000h-20FFFFh	100000h-107FFFh
	40	64/32	Protection Group	210000h-21FFFFh	108000h-10FFFFh
	41	64/32	Protection Group	220000h-22FFFFh	110000h-117FFFh
	42	64/32		230000h-23FFFFh	118000h-11FFFFh
	43	64/32		240000h-24FFFFh	120000h-127FFFh
	44	64/32	Protection Group	250000h-25FFFFh	128000h-12FFFFh
	45	64/32	1 Totection Group	260000h-26FFFFh	130000h-137FFFh
	46	64/32		270000h-27FFFh	138000h-13FFFFh
	47	64/32		280000h-28FFFFh	140000h-147FFFh
Bank B	48	64/32	Protection Group	290000h-29FFFFh	148000h-14FFFFh
Ban	49	64/32	Protection Group	2A0000h-2AFFFFh	150000h-157FFFh
	50	64/32		2B0000h-2BFFFFh	158000h-15FFFFh
	51	64/32		2C0000h-2CFFFFh	160000h-167FFFh
	52	64/32	Protoction Group	2D0000h-2DFFFFh	168000h-16FFFFh
	53	64/32	Protection Group	2E0000h-2EFFFFh	170000h-177FFFh
	54	64/32		2F0000h-2FFFFh	178000h-17FFFFh
	55	64/32		300000h-30FFFFh	180000h-187FFFh
	56	64/32	Protection Group	310000h-31FFFFh	188000h-18FFFFh
	57	64/32	1 Totection Group	320000h-32FFFFh	190000h-197FFFh
	58	64/32		330000h-33FFFFh	198000h-19FFFFh

Table 34. Block Addresses and Protection Groups (continued)

Bank	Block	Size (kbytes/KWords)	Protection Block Group	(x8)	(x16)
	59	64/32		340000h-34FFFFh	1A0000h-1A7FFFh
	60	64/32	Books attack Course	350000h-35FFFFh	1A8000h-1AFFFFh
	61	64/32	Protection Group	360000h-36FFFFh	1B0000h-1B7FFFh
	62	64/32		370000h-37FFFFh	1B8000h-1BFFFFh
	63	64/32		380000h-38FFFFh	1C0000h-1C7FFFh
	64	64/32	Drataction Croup	390000h-39FFFFh	1C8000h-1CFFFFh
	65	64/32	Protection Group	3A0000h-3AFFFFh	1D0000h-1D7FFFh
	66	64/32		3B0000h-3BFFFFh	1D8000h-1DFFFFh
	67	64/32		3C0000h-3CFFFFh	1E0000h-1E7FFFh
	68	64/32	Protection Group	3D0000h-3DFFFFh	1E8000h-1EFFFFh
	69	64/32	Protection Group	3E0000h-3EFFFFh	1F0000h-1F7FFFh
	70	64/32		3F0000h-3FFFFFh	1F8000h-1FFFFFh
	71	64/32		400000h-40FFFFh	200000h-207FFFh
	72	64/32		410000h-41FFFFh	208000h-20FFFFh
	73	64/32	Protection Group	420000h-42FFFFh	210000h-217FFFh
Bank B	74	64/32		430000h-43FFFFh	218000h-21FFFFh
Ban	75	64/32		440000h-44FFFFh	220000h-227FFFh
	76	64/32	Brotaction Group	450000h-45FFFFh	228000h-22FFFFh
	77	64/32	Protection Group	460000h-46FFFFh	230000h-237FFFh
	78	64/32		470000h-47FFFh	238000h-23FFFFh
	79	64/32		480000h-48FFFFh	240000h-247FFFh
	80	64/32	Protection Group	490000h-49FFFFh	248000h-24FFFFh
	81	64/32	Protection Group	4A0000h-4AFFFFh	250000h-257FFFh
	82	64/32		4B0000h-4BFFFFh	258000h-25FFFFh
	83	64/32		4C0000h-4CFFFFh	260000h-267FFFh
	84	64/32	Protection Group	4D0000h-4DFFFFh	268000h-26FFFFh
	85	64/32	Protection Group	4E0000h-4EFFFFh	270000h-277FFFh
	86	64/32	<u> </u>	4F0000h-4FFFFh	278000h-27FFFh
	87	64/32		500000h-50FFFh	280000h-287FFFh
	88	64/32	Protection Group	510000h-51FFFFh	288000h-28FFFFh
	89	64/32	Trotection Group	520000h-52FFFFh	290000h-297FFFh
	90	64/32		530000h-53FFFFh	298000h-29FFFFh

Table 34. Block Addresses and Protection Groups (continued)

Bank	Block	Size (kbytes/KWords)	Protection Block Group	(x8)	(x16)
Bank B	91	64/32	- Protection Group	540000h-54FFFFh	2A0000h-2A7FFFh
	92	64/32		550000h-55FFFFh	2A8000h-2AFFFFh
	93	64/32		560000h-56FFFFh	2B0000h-2B7FFFh
	94	64/32		570000h-57FFFh	2B8000h-2BFFFFh
	95	64/32	- Protection Group	580000h-58FFFFh	2C0000h-2C7FFFh
	96	64/32		590000h-59FFFh	2C8000h-2CFFFFh
	97	64/32		5A0000h-5AFFFFh	2D0000h-2D7FFFh
	98	64/32		5B0000h-5BFFFFh	2D8000h-2DFFFFh
	99	64/32	- Protection Group	5C0000h-5CFFFh	2E0000h-2E7FFh
	100	64/32		5D0000h-5DFFFFh	2E8000h-2EFFFFh
	101	64/32		5E0000h-5EFFFFh	2F0000h-2F7FFFh
	102	64/32		5F0000h-5FFFFh	2F8000h-2FFFFh
	103	64/32	- Protection Group	600000h-60FFFh	300000h-307FFFh
	104	64/32		610000h-61FFFFh	308000h-30FFFFh
	105	64/32		620000h-62FFFFh	310000h-317FFFh
	106	64/32		630000h-63FFFFh	318000h-31FFFFh
	107	64/32	- Protection Group	640000h-64FFFFh	320000h-327FFFh
	108	64/32		650000h-65FFFFh	328000h-32FFFFh
	109	64/32		660000h-66FFFFh	330000h-337FFFh
	110	64/32		670000h-67FFFh	338000h-33FFFFh
	111	64/32	Protection Group	680000h-68FFFFh	340000h-347FFFh
	112	64/32		690000h-69FFFFh	348000h-34FFFFh
	113	64/32		6A0000h-6AFFFh	350000h-357FFFh
	114	64/32		6B0000h-6BFFFFh	358000h-35FFFFh
	115	64/32	Protection Group	6C0000h-6CFFFh	360000h-367FFFh
	116	64/32		6D0000h-6DFFFFh	368000h-36FFFFh
	117	64/32		6E0000h-6EFFFFh	370000h-377FFFh
	118	64/32		6F0000h-6FFFFh	378000h-37FFFFh
	119	64/32	Protection Group	700000h-70FFFh	380000h-387FFFh
	120	64/32		710000h-71FFFFh	388000h-38FFFFh
	121	64/32		720000h-72FFFh	390000h-397FFFh
	122	64/32		730000h-73FFFFh	398000h-39FFFFh

Table 34. Block Addresses and Protection Groups (continued)

Bank	Block	Size (kbytes/KWords)	Protection Block Group	(x8)	(x16)
	123	64/32		740000h-74FFFFh	3A0000h-3A7FFFh
12	124	64/32	Protection Group	750000h-75FFFh	3A8000h-3AFFFFh
	125	64/32	Protection Group	760000h-76FFFh	3B0000h-3B7FFFh
	126	64/32		770000h-77FFFFh	3B8000h-3BFFFFh
	127	64/32		780000h-78FFFFh	3C0000h-3C7FFFh
Bank B	128	64/32	Protection Group	790000h-79FFFh	3C8000h-3CFFFFh
Ban	129	64/32	Frotection Group	7A0000h-7AFFFFh	3D0000h-3D7FFFh
	130	64/32		7B0000h-7BFFFFh	3D8000h-3DFFFFh
	131	64/32		7C0000h-7CFFFh	3E0000h-3E7FFFh
	132	64/32	Protection Group	7D0000h-7DFFFFh	3E8000h-3EFFFFh
	133	64/32	Flotection Group	7E0000h-7EFFFFh	3F0000h-3F7FFFh
	134	64/32		7F0000h-7FFFFh	3F8000h-3FFFFFh
	135	64/32	Protection Group	800000h-80FFFFh	400000h-407FFFh
	136	64/32		810000h-81FFFFh	408000h-40FFFFh
	137	64/32	Frotection Group	820000h-82FFFFh	410000h-417FFFh
	138	64/32		830000h-83FFFFh	418000h-41FFFFh
	139	64/32		840000h-84FFFFh	420000h-427FFFh
	140	64/32	Protection Group	850000h-85FFFFh	428000h-42FFFFh
	141	64/32	1 Totection Group	860000h-86FFFFh	430000h-437FFFh
	142	64/32		870000h-87FFFh	438000h-43FFFFh
	143	64/32		880000h-88FFFFh	440000h-447FFFh
Bank C	144	64/32	Protection Group	890000h-89FFFFh	448000h-44FFFFh
Ban	145	64/32	Protection Group	8A0000h-8AFFFFh	450000h-457FFFh
	146	64/32		8B0000h-8BFFFFh	458000h-45FFFFh
	147	64/32		8C0000h-8CFFFh	460000h-467FFFh
	148	64/32	Protection Group	8D0000h-8DFFFFh	468000h-46FFFFh
	149	64/32	Frotection Group	8E0000h-8EFFFFh	470000h-477FFFh
	150	64/32		8F0000h-8FFFFFh	478000h-47FFFFh
	151	64/32		900000h-90FFFh	480000h-487FFFh
	152	64/32	Protection Group	910000h-91FFFh	488000h-48FFFFh
	153	64/32	Trotection Group	920000h-92FFFh	490000h-497FFFh
	154	64/32		930000h-93FFFFh	498000h-49FFFFh

Table 34. Block Addresses and Protection Groups (continued)

Bank	Block	Size (kbytes/KWords)	Protection Block Group	(x8)	(x16)
	155	64/32		940000h-94FFFFh	4A0000h-4A7FFFh
	156	64/32	Duete etien Cueva	950000h-95FFFFh	4A8000h-4AFFFFh
	157	64/32	Protection Group	960000h-96FFFh	4B0000h-4B7FFFh
	158	64/32	•	970000h-97FFFh	4B8000h-4BFFFFh
	159	64/32		980000h-98FFFFh	4C0000h-4C7FFFh
	160	64/32	Protection Group	990000h-99FFFFh	4C8000h-4CFFFFh
	161	64/32	Protection Group	9A0000h-9AFFFFh	4D0000h-4D7FFFh
	162	64/32		9B0000h-9BFFFFh	4D8000h-4DFFFFh
	163	64/32		9C0000h-9CFFFh	4E0000h-4E7FFFh
	164	64/32	Protection Group	9D0000h-9DFFFFh	4E8000h-4EFFFFh
	165	64/32	Frotection Group	9E0000h-9EFFFh	4F0000h-4F7FFFh
	166	64/32		9F0000h-9FFFFh	4F8000h-4FFFFFh
	167	64/32		A00000h-A0FFFFh	500000h-507FFFh
	168	64/32	Protection Group	A10000h-A1FFFFh	508000h-50FFFFh
	169	64/32		A20000h-A2FFFFh	510000h-517FFFh
Bank C	170	64/32		A30000h-A3FFFFh	518000h-51FFFFh
Ban	171	64/32		A40000h-A4FFFFh	520000h-527FFFh
	172	64/32		A50000h-A5FFFFh	528000h-52FFFFh
	173	64/32	1 Totection Group	A60000h-A6FFFFh	530000h-537FFFh
	174	64/32		A70000h-A7FFFFh	538000h-53FFFFh
	175	64/32		A80000h-A8FFFFh	540000h-547FFFh
	176	64/32	Protection Group	A90000h-A9FFFFh	548000h-54FFFFh
	177	64/32	1 Totection Group	AA0000h-AAFFFFh	550000h-557FFFh
	178	64/32		AB0000h-ABFFFFh	558000h-55FFFFh
	179	64/32		AC0000h-ACFFFh	560000h-567FFh
	180	64/32	Protection Group	AD0000h-ADFFFFh	568000h-56FFFFh
	181	64/32	1 Totection Group	AE0000h-AEFFFFh	570000h-577FFFh
	182	64/32		AF0000h-AFFFFh	578000h-57FFFFh
	183	64/32		B00000h-B0FFFFh	580000h-587FFFh
	184	64/32	Protection Group	B10000h-B1FFFFh	588000h-58FFFFh
	185	64/32	1 Totection Group	B20000h-B2FFFFh	590000h-597FFh
	186	64/32		B30000h-B3FFFFh	598000h-59FFFFh

Table 34. Block Addresses and Protection Groups (continued)

Bank	Block	Size (kbytes/KWords)	Protection Block Group	(x8)	(x16)
	187	64/32	-	B40000h-B4FFFFh	5A0000h-5A7FFFh
	188	64/32	Duete etien Cueva	B50000h-B5FFFFh	5A8000h-5AFFFFh
	189	64/32	Protection Group	B60000h-B6FFFFh	5B0000h-5B7FFFh
	190	64/32		B70000h-B7FFFFh	5B8000h-5BFFFFh
	191	64/32		B80000h-B8FFFFh	5C0000h-5C7FFFh
	192	64/32	Protection Group	B90000h-B9FFFFh	5C8000h-5CFFFFh
	193	64/32	Protection Group	BA0000h-BAFFFFh	5D0000h-5D7FFFh
	194	64/32		BB0000h-BBFFFFh	5D8000h-5DFFFFh
	195	64/32		BC0000h-BCFFFh	5E0000h-5E7FFFh
	196	64/32	Protection Group	BD0000h-BDFFFFh	5E8000h-5EFFFFh
	197	64/32	Frotection Group	BE0000h-BEFFFFh	5F0000h-5F7FFFh
	198	64/32		BF0000h-BFFFFFh	5F8000h-5FFFFFh
	199	64/32		C00000h-C0FFFh	600000h-607FFFh
	200	64/32	Protection Group	C10000h-C1FFFh	608000h-60FFFFh
	201	64/32		C20000h-C2FFFh	610000h-617FFFh
Bank C	202	64/32		C30000h-C3FFFh	618000h-61FFFFh
Ban	203	64/32		C40000h-C4FFFh	620000h-627FFFh
	204	64/32		C50000h-C5FFFh	628000h-62FFFFh
	205	64/32		C60000h-C6FFFh	630000h-637FFFh
	206	64/32		C70000h-C7FFFh	638000h-63FFFFh
	207	64/32		C80000h-C8FFFFh	640000h-647FFFh
	208	64/32	Protection Group	C90000h-C9FFFh	648000h-64FFFFh
	209	64/32	1 Totection Group	CA0000h-CAFFFh	650000h-657FFFh
	210	64/32		CB0000h-CBFFFFh	658000h-65FFFFh
	211	64/32		CC0000h-CCFFFFh	660000h-667FFFh
	212	64/32	Protection Group	CD0000h-CDFFFFh	668000h-66FFFFh
	213	64/32	1 Totection Group	CE0000h-CEFFFh	670000h-677FFFh
	214	64/32		CF0000h-CFFFFh	678000h-67FFFh
	215	64/32		D00000h-D0FFFFh	680000h-687FFFh
	216	64/32	Protection Group	D10000h-D1FFFFh	688000h-68FFFFh
	217	64/32	. Totalion Group	D20000h-D2FFFFh	690000h-697FFh
	218	64/32		D30000h-D3FFFFh	698000h-69FFFFh

Table 34. Block Addresses and Protection Groups (continued)

Bank	Block	Size (kbytes/KWords)	Protection Block Group	(x8)	(x16)
	219	64/32		D40000h-D4FFFFh	6A0000h-6A7FFFh
220	220	64/32	Drotaction Croup	D50000h-D5FFFFh	6A8000h-6AFFFFh
	221	64/32	Protection Group	D60000h-D6FFFFh	6B0000h-6B7FFFh
	222	64/32		D70000h-D7FFFFh	6B8000h-6BFFFFh
	223	64/32		D80000h-D8FFFFh	6C0000h-6C7FFFh
Bank C	224	64/32	Protection Group	D90000h-D9FFFFh	6C8000h-6CFFFFh
Ban	225	64/32	Frotection Group	DA0000h-DAFFFFh	6D0000h-6D7FFFh
	226	64/32		DB0000h-DBFFFFh	6D8000h-6DFFFFh
	227	64/32		DC0000h-DCFFFFh	6E0000h-6E7FFh
	228	64/32	Protection Group	DD0000h-DDFFFFh	6E8000h-6EFFFFh
	229	64/32	Frotection Group	DE0000h-DEFFFFh	6F0000h-6F7FFFh
	230	64/32		DF0000h-DFFFFFh	6F8000h-6FFFFFh
	231	64/32	Protostian Crava	E00000h-E0FFFh	700000h-707FFFh
	232	64/32		E10000h-E1FFFh	708000h-70FFFFh
	233	64/32	Protection Group	E20000h-E2FFFh	710000h-717FFFh
	234	64/32		E30000h-E3FFFh	718000h-71FFFFh
	235	64/32	Protection Group	E40000h-E4FFFh	720000h-727FFFh
	236	64/32		E50000h-E5FFFh	728000h-72FFFFh
	237	64/32	1 Totection Group	E60000h-E6FFFFh	730000h-737FFFh
	238	64/32		E70000h-E7FFFh	738000h-73FFFFh
	239	64/32		E80000h-E8FFFFh	740000h-747FFFh
Bank D	240	64/32	Protection Group	E90000h-E9FFFh	748000h-74FFFFh
Ban	241	64/32	1 Totection Group	EA0000h-EAFFFFh	750000h-757FFFh
	242	64/32		EB0000h-EBFFFFh	758000h-75FFFFh
	243	64/32		EC0000h-ECFFFh	760000h-767FFFh
	244	64/32	Protection Group	ED0000h-EDFFFFh	768000h-76FFFFh
	245	64/32	Flotection Gloup	EE0000h-EEFFFFh	770000h-777FFFh
	246	64/32		EF0000h-EFFFFh	778000h-77FFFFh
	247	64/32		F00000h-F0FFFh	780000h-787FFFh
	248	64/32	Protection Group	F10000h-F1FFFh	788000h-78FFFFh
	249	64/32	1 Totection Group	F20000h-F2FFFFh	790000h-797FFFh
	250	64/32		F30000h-F3FFFFh	798000h-79FFFFh

Table 34. Block Addresses and Protection Groups (continued)

Bank	Block	Size (kbytes/KWords)	Protection Block Group	(x8)	(x16)
	251	64/32		F40000h-F4FFFFh	7A0000h-7A7FFFh
	252	64/32	Protection Group	F50000h-F5FFFh	7A8000h-7AFFFFh
	253	64/32	Frotection Group	F60000h-F6FFFh	7B0000h-7B7FFFh
	254	64/32		F70000h-F7FFFh	7B8000h-7BFFFFh
	255	64/32		F80000h-F8FFFFh	7C0000h-7C7FFFh
	256	64/32	Protection Group	F90000h-F9FFFh	7C8000h-7CFFFFh
	257	64/32	Frotection Group	FA0000h-FAFFFFh	7D0000h-7D7FFFh
	258	64/32		FB0000h-FBFFFFh	7D8000h-7DFFFFh
	259	64/32		FC0000h-FCFFFFh	7E0000h-7E7FFFh
Bank D	260	64/32	Protection Group	FD0000h-FDFFFFh	7E8000h-7EFFFFh
ä	261	64/32		FE0000h-FEFFFFh	7F0000h-7F7FFFh
	262	8/4	Protection Group	FF0000h-FF1FFFh ⁽¹⁾	7F8000h-7F8FFFh ⁽¹⁾
	263	8/4	Protection Group	FF2000h-FF3FFFh ⁽¹⁾	7F9000h-7F9FFFh ⁽¹⁾
	264	8/4	Protection Group	FF4000h-FF5FFFh ⁽¹⁾	7FA000h-7FAFFFh ⁽¹⁾
	265	8/4	Protection Group Protection Group	FF6000h-FF7FFFh ⁽¹⁾	7FB000h-7FBFFFh ⁽¹⁾
	266	8/4		FF8000h-FF9FFFh ⁽¹⁾	7FC000h-7FCFFFh ⁽¹⁾
	267	8/4	Protection Group	FFA000h-FFBFFFh ⁽¹⁾	7FD000h-7FDFFFh ⁽¹⁾
	268	8/4	Protection Group	FFC000h-FFDFFFh ⁽¹⁾	7FE000h-7FEFFFh ⁽¹⁾
	269	8/4	Protection Group	FFE000h-FFFFFFh ⁽¹⁾	7FF000h-7FFFFFh ⁽¹⁾

^{1.} Parameter Blocks.

Appendix B Common Flash Interface (CFI)

The Common Flash Interface is a JEDEC approved, standardized data structure that can be read from the Flash memory device. It allows a system software to query the device to determine various electrical and timing parameters, density information and functions supported by the memory. The system can interface easily with the device, enabling the software to upgrade itself when necessary.

When the Read CFI Query command is issued the addressed bank enters Read CFI Query mode and read operations in the same bank (A22-A19) output the CFI data. *Table 35*, *Table 36*, *Table 37*, *Table 38*, *Table 39* and *Table 40* show the addresses (A-1, A0-A10) used to retrieve the data.

The CFI data structure also contains a security area where a 64 bit unique security number is written (see *Table 40: Security Code Area*). This area can be accessed only in Read mode by the final user. It is impossible to change the security number after it has been written by Numonyx.

Table 35. Query Structure Overview⁽¹⁾

Add	ress	Sub-section Name	Description	
x16	x8	Sub-section Name	Description	
10h	20h	CFI Query Identification String	Command set ID and algorithm data offset	
1Bh	36h	System Interface Information	Device timing & voltage information	
27h	4Eh	Device Geometry Definition	Flash device layout	
40h	80h	Primary Algorithm-specific Extended Query table	Additional information specific to the Primary Algorithm (optional)	
61h	C2h	Security Code Area	64 bit unique device number	

^{1.} Query data are always presented on the lowest order data outputs.

Table 36. CFI Query Identification String⁽¹⁾

Address		Data	Deparintion	Value
x16	х8	Dala	Description	value
10h	20h	0051h		"Q"
11h	22h	0052h	Query Unique ASCII String "QRY"	"R"
12h	24h	0059h		"Y"
13h	26h	0002h	Primary Algorithm Command Set and Control Interface ID code 16 bit	AMD
14h	28h	0000h	ID code defining a specific algorithm	Compatible
15h	2Ah	0040h	Address for Primary Algorithm extended Query table (see <i>Table 39</i>)	P = 40h
16h	2Ch	0000h	Address for Filliary Algorithm extended Query table (see Table 33)	P = 40N
17h	2Eh	0000h	Alternate Vendor Command Set and Control Interface ID Code	NA
18h	30h	0000h	second vendor - specified algorithm supported	IVA
19h	32h	0000h	Address for Alternate Algerithm extended Query table	NA
1Ah	34h	0000h	Address for Alternate Algorithm extended Query table	INA

^{1.} Query data are always presented on the lowest order data outputs (DQ7-DQ0) only. DQ8-DQ15 are '0'.

Table 37. CFI Query System Interface information⁽¹⁾

Address		Data	Description	Value	
x16	х8	Data	Description	value	
1Bh	36h	0027h	V _{CC} Logic Supply Minimum Program/Erase voltage bit 7 to 4BCD value in volts bit 3 to 0BCD value in 100mV	2.7V	
1Ch	38h	0036h	V _{CC} Logic Supply Maximum Program/Erase voltage bit 7 to 4BCD value in volts bit 3 to 0BCD value in 100mV	3.6V	
1Dh	3Ah	00B5h	V _{PP} [Programming] Supply Minimum Program/Erase voltage bit 7 to 4HEX value in volts bit 3 to 0BCD value in 100mV	11.5V	
1Eh	3Ch	00C5h	V _{PP} [Programming] Supply Maximum Program/Erase voltage bit 7 to 4HEX value in volts bit 3 to 0BCD value in 10mV	12.5V	
1Fh	3Eh	0004h	Typical timeout per single byte/Word program = 2 ⁿ μs	16µs	
20h	40h	0000h	Typical timeout for minimum size write buffer program = 2 ⁿ μs	NA	
21h	42h	0009h	Typical timeout per individual block erase = 2 ⁿ ms	512ms	
22h	44h	0000h	Typical timeout for full Chip Erase = 2 ⁿ ms	NA	
23h	46h	0005h	Maximum timeout for byte/Word program = 2 ⁿ times typical	512µs	
24h	48h	0000h	Maximum timeout for write buffer program = 2 ⁿ times typical	NA	
25h	4Ah	0004h	Maximum timeout per individual block erase = 2 ⁿ times typical	8s	
26h	4Ch	0000h	Maximum timeout for Chip Erase = 2 ⁿ times typical	NA	

^{1.} The values given in the above table are valid for both packages.

Table 38. Device Geometry Definition⁽¹⁾

ام ۸						
Add	ress	Data	Description			
x16	х8			= 	Value	
27h	4Eh	0018h	Device Siz	evice Size = 2 ⁿ in number of bytes		
00h	50h	0001h	TBGA64 (x16 only)			
28h	5011	0002h	TSOP56 (x8/x16)	Flash Device Interface Code description	x8, x16 Async.	
29h	52h	0000h	Both Packages			
2Ah	54h	0006h			64	
2Bh	56h	0000h	Maximum	Maximum number of bytes in Multiple-byte program or Page= 2 ⁿ		
2Ch	58h	0003h		Number of Erase Block Regions ⁽¹⁾ . It specifies the number of regions containing contiguous Erase Blocks of the same size.		
2Dh	5Ah	0007h	Erase Bloo	Erase Block Region 1 Information		
2Eh	5Ch	0000h	Number of	Erase Blocks of identical size = 0007h+1	8	
2Fh	5Eh	0020h		k Region 1 Information	8	
30h	60h	0000h	Block size	in Region 1 = 0020h * 256 byte	Kbytes	
31h	62h	00FDh		k Region 2 Information	254	
32h	64h	0000h	Number of	Erase Blocks of identical size = 00FDh+1		
33h	66h	0000h		k Region 2 Information	64	
34h	68h	0001h	Block size	in Region 2 = 0100h * 256 byte	Kbytes	
35h	6Ah	0007h	Erase Bloo	k Region 3 information	8	
36h	6Ch	0000h	Number of	Erase Blocks of identical size = 0007h + 1	ŭ	
37h	6Eh	0020h	Erase Bloo	Erase Block Region 3 information		
38h	70h	0000h	Block size	in region 3 = 0020h * 256 bytes	Kbytes	
39h 3Ah 3Bh 3Ch	72h 74h 76h 78h	0000h 0000h 0000h 0000h	Erase Bloo	k Region 4 information	0	

Erase Block Region 1 corresponds to addresses 000000h to 007FFFh; Erase block Region 2 corresponds to addresses 008000h to 3F7FFFh and Erase Block Region 3 corresponds to addresses 3F8000h to 3FFFFFh.

Table 39. Primary Algorithm-Specific Extended Query table (1)

Address		Data Dassistian		
x16	x8	- Data	Description	Value
40h	80h	0050h		"P"
41h	82h	0052h	Primary Algorithm Extended Query table unique ASCII string "PRI"	"R"
42h	84h	0049h]	" "
43h	86h	0031h	Major version number, ASCII	"1"
44h	88h	0033h	Minor version number, ASCII	"3"
45h	8Ah	000Ch	Address Sensitive Unlock (bits 1 to 0) 00 = required, 01= not required Silicon Revision Number (bits 7 to 2)	Yes
46h	8Ch	0002h	Erase Suspend 00 = not supported, 01 = Read only, 02 = Read and Write	2
47h	8Eh	0001h	Block Protection 00 = not supported, x = number of sectors in per group	1
48h	90h	0001h	Temporary Block Unprotect 00 = not supported, 01 = supported	Yes
49h	92h	0006h	Block Protect /Unprotect 06 = M29DW128F	6
4Ah	94h	00E7	Simultaneous Operations, x = number of blocks (excluding Bank A)	231
4Bh	96h	0000h	Burst Mode, 00 = not supported, 01 = supported	No
4Ch	98h	0002h	Page Mode, 00 = not supported, 02 = 8-Word page	Yes
4Dh	9Ah	00B5h	V _{PP} Supply Minimum Program/Erase voltage bit 7 to 4 HEX value in volts bit 3 to 0 BCD value in 100mV	11.5V
4Eh	9Ch	00C5h	V _{PP} Supply Maximum Program/Erase voltage bit 7 to 4 HEX value in volts bit 3 to 0 BCD value in 100mV	12.5V
4Fh	9Eh	0001h	Top/Bottom Boot Block Flag 00h = Uniform device 01h = 8 x8 Kbyte Blocks or 4KWords, Top and Bottom Boot with Write Protect 02h = Bottom boot device 03h = Top Boot Device 04h = Both Top and Bottom	T/B
50h	A0h	0001h	Program Suspend, 00 = not supported, 01 = supported	Yes
57h	AEh	0004h	Bank Organization, 00 = data at 4Ah is zero X = number of banks	4
58h	B0h	0027h	Bank A information X = number of blocks in Bank A	39

Table 39. Primary Algorithm-Specific Extended Query table (continued)⁽¹⁾

Address		Dete	Decementary	
x16	x8	Data	Description	Value
59h	B2h	0060h	Bank B information X = number of blocks in Bank B	96
5Ah	B4h	0060h	Bank C information X = number of blocks in Bank C	96
5Bh	B6h	0027h	Bank D information X = number of blocks in Bank D	39

^{1.} The values given in the above table are valid for both packages.

Table 40. Security Code Area

Add	Address		Description			
x16	x8	Data	Description			
61h	C3h, C2h	XXXX				
62h	C5h, C4h	XXXX	64 bit: unique device number			
63h	C7h, C6h	XXXX				
64h	C9h, C8h	XXXX				

Appendix C Extended Memory Block

The M29DW128F has an extra block, the Extended Block, that can be accessed using a dedicated command.

This Extended Block is 128 Words in x16 mode and 256 bytes in x8 mode. It is used as a security block (to provide a permanent security identification number) or to store additional information.

The Extended Block is divided into two memory areas of 64 Words each:

- The first one is Factory Locked.
- The second one is Customer Lockable. It is up to the customer to protect it from program operations. Its status is indicated by bit DQ6 and DQ7. When DQ7 is set to '1' and DQ6 to '0', it indicates that this second memory area is Customer Lockable. When DQ7 and DQ6 are both set to '1', it indicates that the second part of the Extended Block is Customer Locked and protected from program operations. Bit DQ7 being permanently locked to either '1' or '0' is another security feature which ensures that a customer lockable device cannot be used instead of a factory locked one.

Bits DQ6 and DQ7 are the most significant bits in the Extended Block Protection Indicator and a specific procedure must be followed to read it. See "Section 3.6.2: Verify Extended Block Protection Indicator" and Table 5 and Table 8, Block Protection, for details of how to read bit DQ7.

The Extended Block can only be accessed when the device is in Extended Block mode. For details of how the Extended Block mode is entered and exited, refer to the *Section 6.1.11: Program command* and *Section 6.3.2: Exit Extended Block command* paragraphs, and to *Table 15* and *Table 16*, Block Protection Commands.

C.1 Factory Locked Section of the Extended Block

The first section of The Extended Block is permanently protected from program operations and cannot be unprotected. The Random Number, Electronic Serial Number (ESN) and Security Identification Number (see *Table 41: Extended Block Address and Data*) are written in this section in the factory.

C.2 Customer Lockable Section of the Extended Block

The device is delivered with the second section of the Extended Block "Customer Lockable": bits DQ7 and DQ6 are set to '1' and '0' respectively. It is up to the customer to program and protect this section of the Extended Block but care must be taken because the protection is not reversible.

There are three ways of protecting this section:

- Issue the Enter Extended Block command to place the device in Extended Block mode, then use the In-System Technique with RP either at V_{IH} or at V_{ID}. Refer to Section D.2: In-System technique in Appendix D: High Voltage Block Protection, and to the corresponding flowcharts Figure 25 and Figure 26 for a detailed explanation of the technique).
- Issue the Enter Extended Block command to place the device in Extended Block mode, then use the Programmer Technique. Refer to Section D.1: Programmer technique in Appendix D: High Voltage Block Protection, and to the corresponding flowcharts Figure 23 and Figure 24 for a detailed explanation of the technique).
- Issue a Set Extended Block Protection bit command to program the Extended Block Protection bit to '1' thus preventing the second section of the Extended Block from being programmed.

Bit DQ6 of the Extended Block Protection Indicator is automatically set to '1' to indicate that the second section of the Extended Block is Customer Locked.

Once the Extended Block is programmed and protected, the Exit Extended Block command must be issued to exit the Extended Block mode and return the device to Read mode.

Table 41.	Extended	Block	Address	and Data

Device	Addre	ess ⁽¹⁾	Data	
	x8	x16	Factory Locked	Customer Lockable
M29DW128F	000000h- 00007Fh	000000h- 00003Fh	Random Number, ESN ⁽²⁾ , Security Identification Number	Unavailable
	000080h- 0000FFh	000040h- 00007Fh	Unavailable	Determined by Customer

^{1.} See Table 34: Block Addresses and Protection Groups.

^{2.} ESN = Electronic Serial Number.

Appendix D High Voltage Block Protection

The High Voltage Block Protection can be used to prevent any operation from modifying the data stored in the memory. The blocks are protected in groups, refer to *Appendix A*, *Table 34* for details of the Protection Groups. Once protected, Program and Erase operations within the protected group fail to change the data.

There are three techniques that can be used to control Block Protection, these are the Programmer technique, the In-System technique and Temporary Unprotection. Temporary Unprotection is controlled by the Reset/Block Temporary Unprotection pin, \overline{RP} ; this is described in the Signal Descriptions section.

To protect the Extended Block issue the Enter Extended Block command and then use either the Programmer or In-System technique. Once protected issue the Exit Extended Block command to return to read mode. The Extended Block protection is irreversible, once protected the protection cannot be undone.

D.1 Programmer technique

The Programmer technique uses high (V_{ID}) voltage levels on some of the bus pins. These cannot be achieved using a standard microprocessor bus, therefore the technique is recommended only for use in Programming Equipment.

To protect a group of blocks follow the flowchart in *Figure 23: Programmer equipment Group Protect flowchart*. To unprotect the whole chip it is necessary to protect all of the groups first, then all groups can be unprotected at the same time. To unprotect the chip follow *Figure 24: Programmer equipment Chip Unprotect flowchart. Table 42: Programmer technique Bus operations, 8-bit or 16-bit mode, gives a summary of each operation.*

The timing on these flowcharts is critical. Care should be taken to ensure that, where a pause is specified, it is followed as closely as possible. Do not abort the procedure before reaching the end. Chip Unprotect can take several seconds and a user message should be provided to show that the operation is progressing.

D.2 In-System technique

The In-System technique requires a high voltage level on the Reset/Blocks Temporary Unprotect pin, $\overline{\text{RP}}^{(1)}$. This can be achieved without violating the maximum ratings of the components on the microprocessor bus, therefore this technique is suitable for use after the memory has been fitted to the system.

To protect a group of blocks follow the flowchart in *Figure 25: In-System equipment Group Protect flowchart*. To unprotect the whole chip it is necessary to protect all of the groups first, then all the groups can be unprotected at the same time. To unprotect the chip follow *Figure 26: In-System equipment Chip Unprotect flowchart*.

The timing on these flowcharts is critical. Care should be taken to ensure that, where a pause is specified, it is followed as closely as possible. Do not allow the microprocessor to service interrupts that will upset the timing and do not abort the procedure before reaching the end. Chip Unprotect can take several seconds and a user message should be provided to show that the operation is progressing.

Note: \overline{RP} can be either at V_{IH} or at V_{ID} when using the In-System Technique to protect the Extended Block.

Table 42. Programmer technique Bus operations, 8-bit or 16-bit mode

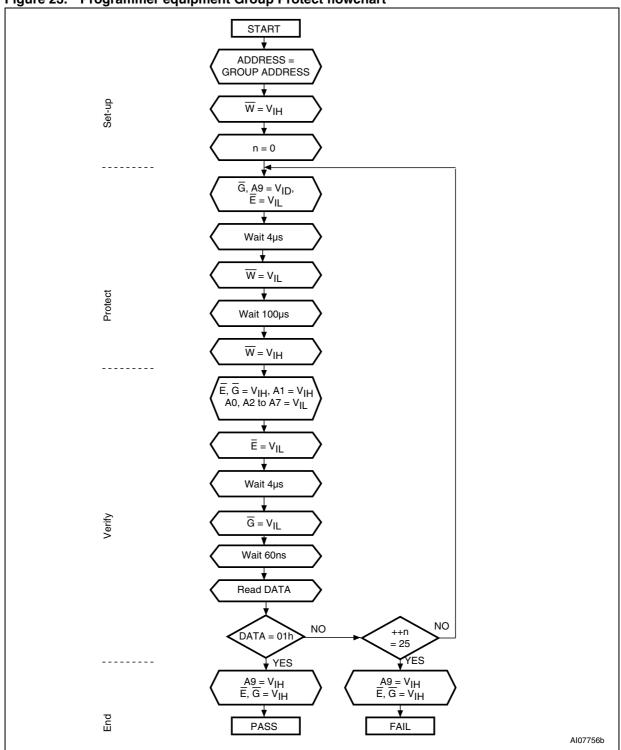
Operation	Ē	G	W	Address Inputs A0-A22	Data Inputs/Outputs DQ15A-1, DQ14-DQ0
Block (Group) Protect ⁽¹⁾	V_{IL}	V _{ID}	V _{IL} Pulse	$A9 = V_{ID}$, A12-A22 Block Address Others = X	х
Chip Unprotect	V_{ID}	V_{ID}	V _{IL} Pulse	$A6 = V_{IH}, A9 = V_{ID}, A12 = V_{IH},$ $A15 = V_{IH} Others = X$	Х
Block (Group) Protect Verify	V _{IL}	V _{IL}	V _{IH}	$A0 = V_{IL}$, $A1 = V_{IH}$, $A2-A7 = V_{IL}$, $A9 = V_{ID}$, $A12-A22$ Block Address Others = X	Pass = xx01h Retry = xx00h.
Block (Group) Unprotect Verify	V _{IL}	V _{IL}	V _{IH}	$A0 = V_{IL}, A1 = V_{IH}, A2 - A5 = V_{IL},$ $A6 = V_{IH}, A7 = V_{IL},$ $A9 = V_{ID}, A12-A22 \text{ Block Address}$ Others = X	Pass = xx00h Retry = xx01h.

^{1.} Block Protection Groups are shown in Appendix A, Table 34.

M29DW128F Flowcharts

Appendix E Flowcharts



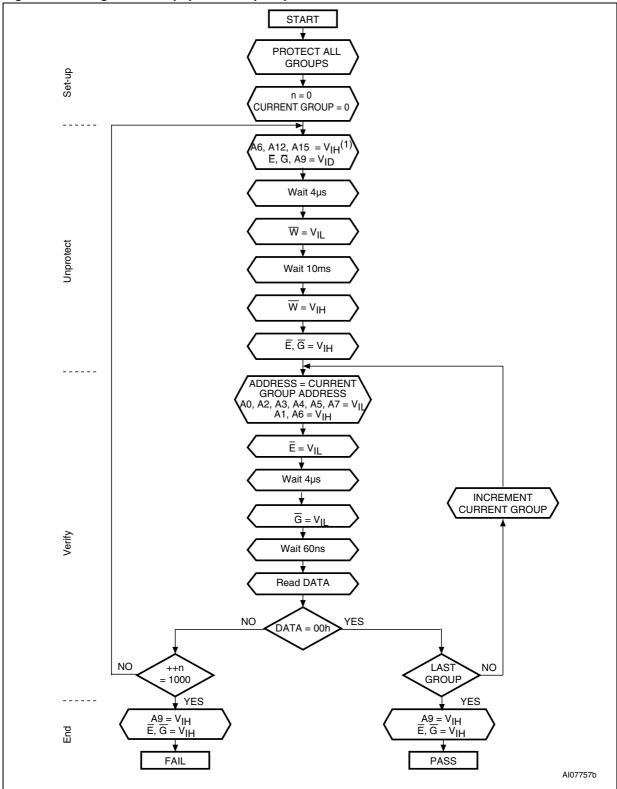


^{1.} Block Protection Groups are shown in Appendix A, Table 34.

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Figure 24. Programmer equipment Chip Unprotect flowchart



^{1.} Block Protection Groups are shown in Appendix A, Table 34.

M29DW128F Flowcharts

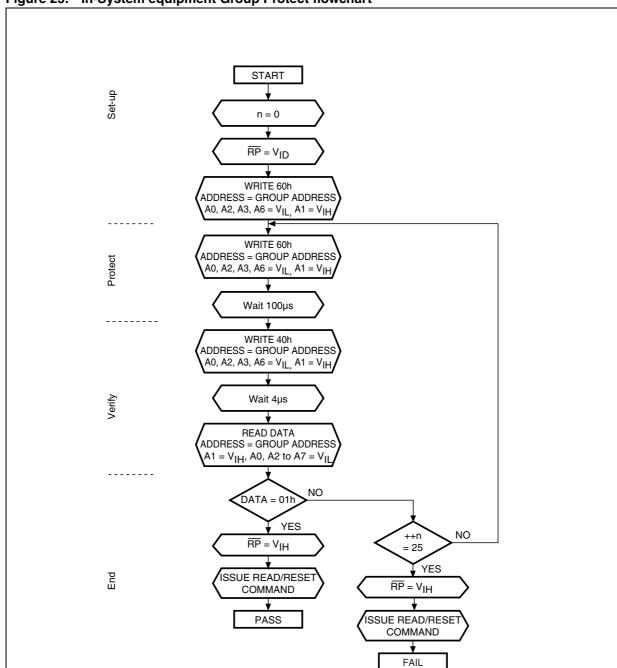


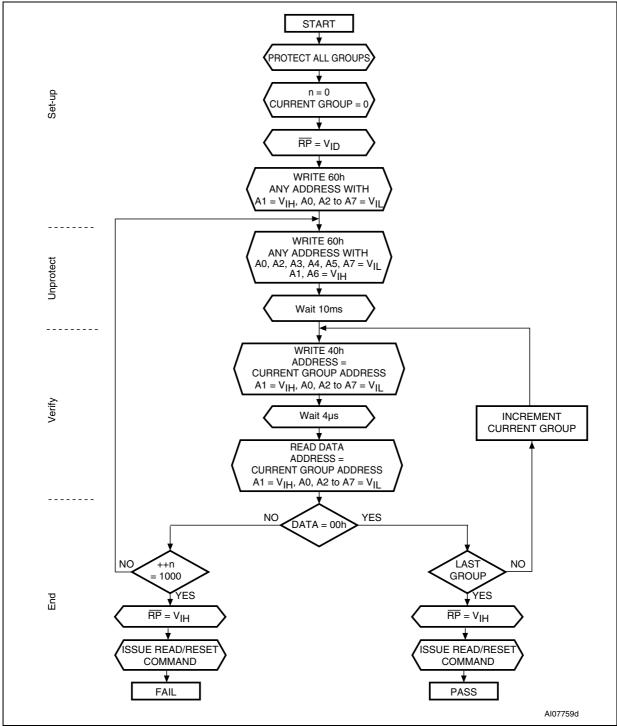
Figure 25. In-System equipment Group Protect flowchart

- 1. Block Protection Groups are shown in Appendix A, Table 34.
- 2. \overline{RP} can be either at V_{IH} or at V_{ID} when using the In-System Technique to protect the Extended Block.

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Flowcharts M29DW128F

Figure 26. In-System equipment Chip Unprotect flowchart



^{1.} Block Protection Groups are shown in Appendix A, Table 34.

M29DW128F Flowcharts

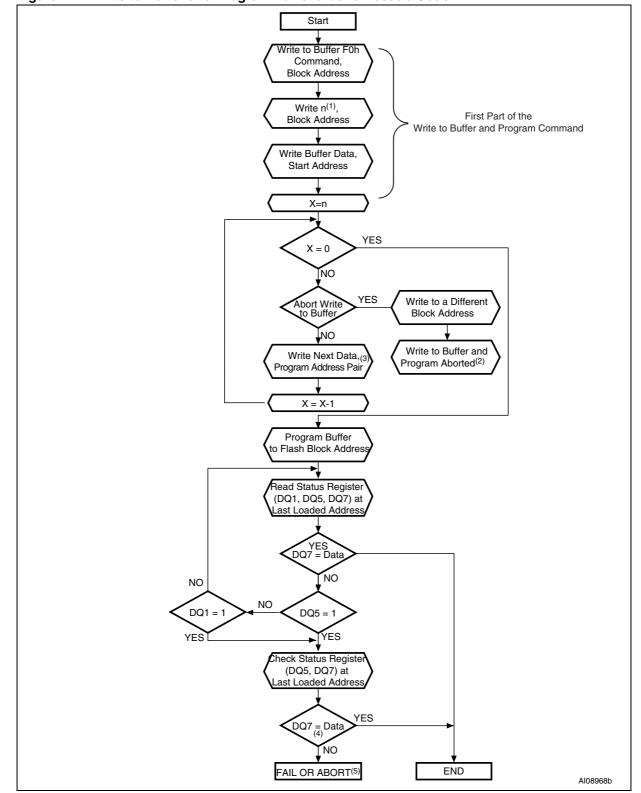


Figure 27. Write to Buffer and Program flowchart and Pseudo Code

- 1. n+1 is the number of addresses to be programmed.
- 2. A Write to Buffer and Program Abort and Reset must be issued to return the device in Read mode.

Flowcharts M29DW128F

3. When the block address is specified, any address in the selected block address space is acceptable. However when loading Write Buffer address with data, all addresses must fall within the selected Write Buffer page.

- 4. DQ7 must be checked since DQ5 and DQ7 may change simultaneously.
- 5. If this flowchart location is reached because DQ5='1', then the Write to Buffer and Program command failed. If this flowchart location is reached because DQ1='1', then the Write to Buffer and Program command aborted. In both cases, the appropriate reset command must be issued to return the device in Read mode: a Reset command if the operation failed, a Write to Buffer and Program Abort and Reset command if the operation aborted.

6. See Table 11 and Table 12, for details on Write to Buffer and Program command sequence.

M29DW128F Revision history

Revision history

Table 43. Document revision history

Date	Revision	Changes
02-Aug-2005	1.0	First Issue derived from the M29DW128F/FS datasheet revision 0.5.
13-Oct-2005	2.0	Table 18: Program, Erase Times and Program, Erase Endurance Cycles updated.
02-Dec-2005	3.0	Datasheet status updated to "FULL DATASHEET". Program Suspend Latency time updated in <i>Table 18: Program, Erase Times and Program, Erase Endurance Cycles</i> .
13-Mar-2006	4.0	Table 19: Status Register bits: DQ7 changed into DQ7 for Program, Program Error and Program during Erase Suspend operations. Section 6.2.1: Write to Buffer and Program command, and Section 6.2.2: Write to Buffer and Program Confirm command updated to cover 8-bit mode. Note 2, Note 3, and Note 4 updated in Table 13: Fast Program Commands, 8-bit mode.
13-Jun-2006	5	Blank Verify command added in <i>Section 6: Command interface</i> . Input/output supply voltage, V _{CCQ} , removed.
20-Jun-2006	6	Address Inputs A7-A0 modified for NVMPbits in <i>Table 17: Protection Command Addresses</i> .
26-Oct-2006	7	Updated <i>Table 19: Status Register bits</i> ; updated blank verify command description and removed verify command in <i>Section 6: Command interface</i> .
10-Dec-2007	8	Applied Numonyx branding.

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